# 专业PCB打样工厂,24小时加急出货

# **TSC87251G1A**

# **Extended 8-bit Microcontroller with Serial Communication Interfaces**

# **1. Description**

The TSC87251G1A products are derivatives of the TEMIC Microcontroller family based on the extended 8-bit C251 Architecture. This family of products is tailored to 8-bit microcontroller applications requiring an increased instruction throughput, a reduced operating frequency or a larger addressable memory space. The architecture can provide a significant code size reduction when compiling C programs while fully preserving the legacy of C51 assembly routines.

The TSC87251G1A derivatives are pin-out and software compatible with standard 80C51/Fx/Rx with extended on-chip data memory (1 Kbyte RAM), on-chip memory (16 Kbytes EPROM/OTPROM) and up to 256 Kbytes of external code and data.

They provide transparent enhancements to Intel's 87C251Sx family with an additional Synchronous Serial Link Controller (SSLC supporting  $I^2C$ ,  $\mu$ Wire and SPI protocols), a Keyboard interrupt interface and Power Monitoring and Management features.

#### Notes:

This Datasheet provides the technical description of the TSC87251G1A derivatives. For further information on the device usage, please request the TSC80251 Programmers' Guide and the TSC80251G1 Design Guide. For information on the Mask ROM and ROMless devices, please refer to the TSC87251G1D Datasheet.

# **2.** Typical Applications

- ISDN terminals
- High-Speed modems
- PABX (SOHO)
- Networking
- Line cards
- Computer peripherals
- Printers

- Plotters
- Scanners
- Banking machines
- Barcode readers
- Smart cards readers
- WWW.DZSC.CO High-end digital monitors
- High-end joysticks



Purchase of TEMIC I<sup>2</sup>C components conveys a license under the Philips I<sup>2</sup>C Patent Rights to use these components in an I<sup>2</sup>C system, provided that the system conforms to the I<sup>2</sup>C Standard Specification as defined by Philips.

# TEMIC Semiconductors

### 3. Features

- Pin–Out and software compatibility with standard 80C51 products and 80C51FA/FB/RA/RB
- Plug-in replacement of Intel's 80C251Sx
- C251 core: Intel's MCS<sup>®</sup>251 step A compliance
  - 125 ns Instruction cycle time at 16 MHz
  - 40–byte Register File
  - Registers Accessible as Bytes, Words or Dwords
  - Six-stage instruction Pipeline
  - 16-bit Internal Code Fetch
- Enriched C51 Instruction Set
  - 16-bit and 32-bit ALU
  - Compare and Conditional Jump Instructions
  - Expanded Set of Move Instructions
- Linear Addressing
- 1 Kbyte of on-chip RAM
- External memory space (Code/Data) programmable from 64 Kbytes to 256 Kbytes
- TSC87251G1A: 16 Kbytes of on-chip EPROM/ OTPROM (production with TSC83251G1D: on-chip masked ROM version)
- SINGLE–PULSE Programming Algorithm
- Four 8–bit parallel I/O Ports (Ports 0, 1, 2 and 3 of the standard 80C51)
- Serial I/O Port: full duplex UART (80C51 compatible) with independent Baud Rate Generator
- SSLC: Synchronous Serial Link Controller
  - I<sup>2</sup>C master only protocol
  - μWire and SPI master only protocol
- Three 16–bit Timers/Counters (Timers 0, 1 and 2 of the standard 80C51)
- EWC: Event and Waveform Controller
  - Compatible with Intel's Programmable Counter Array (PCA)
  - Common 16-bit Timer/Counter reference with four possible clock sources (Fosc/4, Fosc/12, Timer 1 and external input)
  - Five modules with four programmable modes:
    - 16-bit software Timer/Counter
    - 16–bit Timer/Counter Capture Input and software pulse measurement
    - High-speed output and 16-bit software Pulse Width Modulation (PWM)
    - 8-bit hardware PWM without overhead
  - 16-bit Watchdog Timer/Counter capability

- Secured 14–bit Hardware Watchdog Timer
- Power Monitoring and Management
  - Power–Fail reset
  - Power–On reset (integrated on the chip)
  - Power–Off flag (cold and warm resets)
  - Software programmable system clock
  - Idle and Power–Down modes
- Keyboard interrupt interface on Port 1
- ONCE mode and full speed Real-Time In-Circuit Emulation support (Third Party Vendors)
- Speed ranges:
  - 0 to 16 MHz
- Supply ranges:
  - 5 V ±10 %
- Temperature ranges:
  - Commercial (0°C to +70°C)
  - Industrial (-40°C to +85°C)
  - Option: extended range (-55°C to +125°C)
- Packages:
  - PDIL 40, PLCC 44
  - UV–Window CQPJ 44
  - Options: known good dice and ceramic packages

TEMIC Semiconductors

TSC87251G1A

# 4. Block Diagram



Figure 1. TSC87251G1A Block Diagram

# TEMIC Semiconductors

### 5. Pin Description

#### 5.1. Pinout







Figure 3. TSC87251G1A 44-pin PLCC/CQPJ Package



DIP	PLCC	Name	DIP	PLCC	Name
	1	VSS1		23	VSS2
1	2	P1.0/T2	21	24	P2.0/A8
2	3	P1.1/T2EX	22	25	P2.1/A9
3	4	P1.2/ECI	23	26	P2.2/A10
4	5	P1.3/CEX0	24	27	P2.3/A11
5	6	P1.4/CEX1	25	28	P2.4/A12
6	7	P1.5/CEX2/MISO	26	29	P2.5/A13
7	8	P1.6/CEX3/SCL/SCK	27	30	P2.6/A14
8	9	P1.7/A17/CEX4/SDA/MOSI	28	31	P2.7/A15
9	10	RST	29	32	PSEN#
10	11	P3.0/RXD	30	33	ALE/PROG#
	12	NC		34	NC
11	13	P3.1/TXD	31	35	EA#/VPP
12	14	P3.2/INT0#	32	36	P0.7/AD7
13	15	P3.3/INT1#	33	37	P0.6/AD6
14	16	P3.4/T0	34	38	P0.5/AD5
15	17	P3.5/T1	35	39	P0.4/AD4
16	18	P3.6/WR#	36	40	P0.3/AD3
17	19	P3.7/A16/RD#	37	41	P0.2/AD2
18	20	XTAL2	38	42	P0.1/AD1
19	21	XTAL1	39	43	P0.0/AD0
20	22	VSS	40	44	VDD

### Table 1. TSC87251G1A Pin Assignment

### 5.2. Signals

#### Table 2. TSC87251G1A Signal Descriptions

Signal Name	Туре	Description	
A17	0	18 <sup>th</sup> Address Bit	P1.7
		Output to memory as 18th external address bit (A17) in extended bus applications, depending on the values of bits RD0 and RD1 in UCONFIG0 byte (see Table 13).	
A16	0	17 <sup>th</sup> Address Bit	P3.7
		Output to memory as 17th external address bit (A16) in extended bus applications, depending on the values of bits RD0 and RD1 in UCONFIG0 byte (see Table 13).	
A15:8 <sup>(1)</sup>	0	Address Lines	P2.7:0
		Upper address lines for the external bus.	
AD7:0 <sup>(1)</sup>	I/O	Address/Data Lines	P0.7:0
		Multiplexed lower address lines and data for the external memory.	
ALE	0	Address Latch Enable	
		ALE signals the start of an external bus cycle and indicates that valid address information are available onlines A16/A17 and A7:0. An external latch can use ALE to demultiplex the address from address/databus.	
CEX4:0	0	PCA Input/Output pins	P1.7:3
		CEXx are input signals for the PCA capture mode and output signals for the PCA compare and PWM modes.	
EA#	Ι	External Access Enable	
		EA# directs program memory accesses to on-chip or off-chip code memory. For EA#= 0, all program memory accesses are off-chip. For EA#= 1, an access is on-chip EPROM/OTPROM if the address is within the range of the on- chip EPROM/OTPROM; otherwise the access is off-chip. The value of EA# is latched at reset.	

TEMIC Semiconductors

Signal Name	Туре	Description	Alternate Function
ECI	0	PCA External Clock input	P1.2
		ECI is the external clock input to the 16-bit PCA timer.	
MISO	I/O	SPI Master Input Slave Output line When SPI is in master mode, MISO receives data from the slave peripheral. When SPI is in slave mode, MISO outputs data to the master controller.	P1.5
MOSI	I/O	SPI Master Output Slave Input line	P1.7
		When SPI is in master mode, MOSI outputs data to the slave peripheral. When SPI is in slave mode, MOSI receives data from the master controller.	
INT1:0#	Ι	External Interrupts 0 and 1.	P3.3:2
		INT1#/INT0# inputs set IE1:0 in the TCON register. If bits IT1:0 in the TCON register are set, bits IE1:0 are set by a falling edge on INT1#/INT0#. If bits IT1:0 are cleared, bits IE1:0 are set by a low level on INT1#/INT0#	
P0.0:7	I/O	Port 0	AD7:0
		P0 is an 8-bit open-drain bidirectional I/O port.	
P1.0:7	I/O	Port 1 P1 is an 8–bit bidirectional I/O port with internal pull–ups. P1 provides interrupt capability for a keyboard interface.	
P2.0:7	I/O	Port 2	A15:8
D2 0 7	T/O	P2 is an 8-bit bidirectional I/O port with internal pull-ups.	
P3.0:7	1/0	Port 3 P3 is an 8–bit bidirectional I/O port with internal pull–ups.	
PROG#	0	Programming Pulse input	
		The programming pulse is applied to this input for programming the on-chip EPROM/ OTPROM.	
PSEN#	0	Program Store Enable/Read signal output	
		PSEN# is asserted for a memory address range that depends on bits RD0 and RD1 in UCON- FIG0 byte (see Table 13).	
RD#	0	Read or 17 <sup>th</sup> Address Bit (A16)	P3.7
		Read signal output to external data memory depending on the values of bits RD0 and RD1 in UCONFIG0 byte (see Table 13).	
RST	Ι	Reset input to the chip	
		Holding this pin high for 64 oscillator periods while the oscillator is running resets the device. The Port pins are driven to their reset conditions when a voltage greater than $V_{IH1}$ is applied, whether or not the oscillator is running.	
		This pin has an internal pull-down resistor which allows the device to be reset by connecting a capacitor between this pin and VDD.	
		Asserting RST when the chip is in Idle mode or Power–Down mode returns the chip to normal operation.	
RXD	I/O	Receive Serial Data	P3.0
		RXD sends and receives data in serial I/O mode 0 and receives data in serial modes I/O 1, 2 and 3.	
SCL	I/O	I <sup>2</sup> C Serial Clock	P1.6
		SCL outputs the serial clock to slave peripherals.	
SCK	I/O	SPI Serial Clock	P1.6
		SCK outputs clock to the slave peripheral.	
SDA	I/O	I <sup>2</sup> C Serial Data	P1.7
		SDA is the bidirectional I <sup>2</sup> C data line.	
T1:0	I/O	Timer 1:0 External Clock Inputs	
		when umer 1:0 operates as a counter, a failing edge on the 11:0 pin increments the count.	



Signal Name	Туре	Description	Alternate Function		
T2	I/O	Timer 2 Clock Input/Output	P1.0		
		For the timer 2 capture mode, T2 is the external clock input. For the Timer 2 clock–out mode, T2 is the clock output.			
T2EX	Ι	Timer 2 External Input	P1.1		
		In timer 2 capture mode, a falling edge initiates a capture of the timer 2 registers. In auto-reload mode, a falling edge causes the timer 2 register to be reloaded. In the up-down counter mode, this signal determines the count direction: 1= up, 0= down.			
TXD	I/O	Transmit Serial Data	P3.1		
		TXD outputs the shift clock in serial I/O mode 0 and transmits data in serial I/O modes 1, 2 and 3.			
VDD	PWR	Digital Supply Voltage			
		Connect this pin to +5V or +3V supply voltage.			
VSS	GND	Circuit Ground			
		Connect this pin to ground.			
VSS1	GND	Secondary Ground 1			
		This ground is provided to reduce ground bounce and improve power supply bypassing. Con- nection of this pin to ground is recommended. However, when using the TSC87251G1A as a pin-for-pin replacement for a 8xC51 product, VSS1 can be unconnected without loss of com- patibility.			
		Not available on DIP package.			
VSS2	GND	Secondary Ground 2			
		This ground is provided to reduce ground bounce and improve power supply bypassing. Con- nection of this pin to ground is recommended. However, when using the TSC87251G1A as a pin–for–pin replacement for a 8xC51 product, VSS2 can be unconnected without loss of com- patibility.			
		Not available on DIP package.			
VPP	Ι	Programming Supply Voltage			
		The programming supply voltage is applied to this input for programming the on-chip EPROM/ OTPROM			
WR#	0	Write	P3.6		
		Write signal output to external memory.			
XTAL1	Ι	Input to the on-chip inverting oscillator amplifier			
		To use the internal oscillator, a crystal/resonator circuit is connected to this pin. If an external oscillator is used, its output is connected to this pin. XTAL1 is the clock source for internal timing.			
XTAL2	0	Output of the on-chip inverting oscillator amplifier			
		To use the internal oscillator, a crystal/resonator circuit is connected to this pin. If an external oscillator is used, leave XTAL2 unconnected.			

Note:

1. The description of A15:8/P2.7:0 and AD7:0/P0.7:0 are for the non-page mode chip configuration. If the chip is configured in page mode operation, port 0 carries the lower address bits (A7:0) while port 2 carries the upper address bits (A15:8) and the data (D7:0).

## 6. Address Spaces

The TSC87251G1A implements four different address spaces:

- On-chip EPROM/OTPROM program/code memory
- On-chip RAM data memory
- Special Function Registers (SFRs)
- Configuration array

### 6.1. Program/Code Memory

The TSC87251G1A implements 16 Kbytes of on-chip EPROM/OTPROM for program/code memory. Figure 4 shows the split of the internal and external program/code memory spaces. If EA# is tied to a high level, the 16–Kbyte on-chip program/code memory is mapped in the lower part of segment FF: where the C251 core jumps after reset. The rest of the program/code memory space is mapped to the external memory. If EA# is tied to a low level, the internal program/code memory is not used and all the accesses are directed to the external memory.



#### Figure 4. Program/Code Memory Mapping

Notes:

Special care should be taken when the Program Counter (PC) increments:

If the program executes exclusively from on-chip code memory (not from external memory), beware of executing code from the upper eight bytes of the on-chip EPROM (FF:3FF8h–FF:3FFFFh). Because of its pipeline capability, the TSC87251G1A may attempt to prefetch code from external memory (at an address above FF:3FFFFh) and thereby disrupt I/O Ports 0 and 2. Fetching code constants from these 8 bytes does not affect Ports 0 and 2.

When PC reaches the end of segment FF:, it loops to the reset address FF:0000h (for compatibility with the C51 Architecture). When PC increments beyond the end of segment FE:, it continues at the reset address FF:0000h (linearity). When PC increments beyond the end of segment 01:, it loops to the beginning of segment 00: (this prevents from its going into the reserved area).

TEMIC Semiconductors

# TSC87251G1A

### 6.2. Data Memory

The TSC87251G1A implements 1 Kbyte of on-chip data RAM. Figure 5 shows the split of the internal and external data memory spaces. This memory is mapped in the data space just over the 32 bytes of registers area (see TSC80251 Programmers' Guide). Hence, the part of the on-chip RAM located from 20h to FFh is bit addressable. This on-chip RAM is not accessible through the program/code memory space.

For faster computation with the on-chip EPROM code of the TSC87251G1A, its upper 8 Kbytes are also mapped in the upper part of the region 00: if the On-Chip Code Memory Map configuration bit is cleared (EMAP# bit in UCONFIG1 byte, see Figure 7). However, if EA# is tied to a low level, the TSC87251G1A derivative is running as a ROMless product and the code is actually fetched in the corresponding external memory (i.e. the upper 8 Kbytes of the lower 16 Kbytes of the segment FF:). If EMAP# bit is set, the on-chip EPROM is not accessible through the region 00:.



All the accesses to the portion of the data space with no on-chip memory mapped onto are redirected to the external memory.

Figure 5. Data Memory Mapping

### **6.3. Special Function Registers**

The Special Function Registers (SFRs) of the TSC87251G1A derivatives fall into the categories detailed in Table 3 to Table 11.

SFRs are placed in a reserved on-chip memory region S: which is not represented in the data memory mapping (Figure 5). The relative addresses within S: of these SFRs are provided together with their reset values in Table 12. They are upward compatible with the SFRs of the standard 80C51 and the Intel's 80C251Sx family. In this table, the C251 core registers are in italics and are described in the TSC80251 Programmer's Guide. The other SFRs are described in the TSC80251G1 Design Guide. All the SFRs are bit-addressable using the C251 instruction set.

#### Table 3. C251 Core SFRs

Mnemonic	Name	Mnemonic	Name
ACC <sup>(1)</sup>	Accumulator	SPH <sup>(1)</sup>	Stack Pointer High – MSB of SPX
B <sup>(1)</sup>	B Register	DPL <sup>(1)</sup>	Data Pointer Low byte - LSB of DPTR
PSW	Program Status Word	DPH <sup>(1)</sup>	Data Pointer High byte – MSB of DPTR
PSW1	Program Status Word 1	DPXL <sup>(1)</sup>	Data Pointer Extended Low byte of DPX – Region number
SP <sup>(1)</sup>	Stack Pointer – LSB of SPX		

Note:

1. These SFRs can also be accessed by their corresponding registers in the register file.

#### Table 4. I/O Port SFRs

Mnemonic	Name	Mnemonic	Name
P 0	Port 0	P 2	Port 2
P 1	Port 1	P 3	Port 3

#### Table 5. Timers SFRs

Mnemonic	Name	Mnemonic	Name
TL0	Timer/Counter 0 Low Byte	TMOD	Timer/Counter 0 and 1 Modes
TH0	Timer/Counter 0 High Byte	T2CON	Timer/Counter 2 Control
TL1	Timer/Counter 1 Low Byte	T2MOD	Timer/Counter 2 Mode
TH1	Timer/Counter 1 High Byte	RCAP2L	Timer/Counter 2 Reload/Capture Low Byte
TL2	Timer/Counter 2 Low Byte	RCAP2H	Timer/Counter 2 Reload/Capture High Byte
TH2	Timer/Counter 2 High Byte	WDTRST	WatchDog Timer Reset
TCON	Timer/Counter 0 and 1 Control		

#### Table 6. Serial I/O Port SFRs

Mnemonic	Name	Mnemonic	Name
SCON	Serial Control	SADDR	Slave Address
SBUF	Serial Data Buffer	BRL	Baud Rate Reload
SADEN	Slave Address Mask	BDRCON	Baud Rate Control

#### Table 7. SSLC SFRs

Mnemonic	Name	Mnemonic	Name
SSCON	Synchronous Serial control	SSCS	Synchronous Serial Control and Status
SSDAT	Synchronous Serial Data	SSBR	Synchronous Serial Bit Rate



Mnemonic	Name	Mnemonic	Name
CCON	EWC-PCA Timer/Counter Control	CCAP1L	EWC-PCA Compare Capture Module 1 Low Register
CMOD	EWC-PCA Timer/Counter Mode	CCAP2L	EWC–PCA Compare Capture Module 2 Low Register
CL	EWC-PCA Timer/Counter Low Register	CCAP3L	EWC–PCA Compare Capture Module 3 Low Register
СН	EWC-PCA Timer/Counter High Register	CCAP4L	EWC-PCA Compare Capture Module 4 Low Register
CCAPM0	EWC–PCA Timer/Counter Mode 0	CCAP0H	EWC–PCA Compare Capture Module 0 High Register
CCAPM1	EWC-PCA Timer/Counter Mode 1	CCAP1H	EWC-PCA Compare Capture Module 1 High Register
CCAPM2	EWC–PCA Timer/Counter Mode 2	CCAP2H	EWC–PCA Compare Capture Module 2 High Register
CCAPM3	EWC-PCA Timer/Counter Mode 3	ССАР3Н	EWC–PCA Compare Capture Module 3 High Register
CCAPM4	EWC-PCA Timer/Counter Mode 4	CCAP4H	EWC–PCA Compare Capture Module 4 High Register
CCAP0L	EWC–PCA Compare Capture Module 0 Low Register		

#### Table 8. Event Waveform Control SFRs

#### Table 9. System Management SFRs

Mnemonic	Name	Mnemonic	Name
PCON	Power Control	PFILT	Power Filter
POWM	Power Management	CKRL	Clock Reload

#### Table 10. Interrupt SFRs

Mnemonic	Name	Mnemonic	Name
IE0	Interrupt Enable Control 0	IPL0	Interrupt Priority Control Low 0
IE1	Interrupt Priority Control 1	IPH1	Interrupt Priority Control High 1
IPH0	Interrupt Priority Control High 0	IPL1	Interrupt Priority Control Low 1

#### Table 11. Keyboard Interface SFRs

Mnemonic	Name	Mnemonic	Name
P1IE	Port 1 Input Interrupt Enable	P1LS	Port 1 Level Selection
P1F	Port 1 Flag		

	0/8	1/9	2/A	3/B	4/C	5/D	6/E	7/F	
F8h		CH 0000 0000	CCAP0H 0000 0000	CCAP1H 0000 0000	CCAP2H 0000 0000	CCAP3H 0000 0000	CCAP4H 0000 0000		FFh
F0h	B <sup>(1)</sup> 0000 0000								F7h
E8h		CL 0000 0000	CCAP0L 0000 0000	CCAP1L 0000 0000	CCAP2L 0000 0000	CCAP3L 0000 0000	CCAP4L 0000 0000		EFh
E0h	ACC <sup>(1)</sup> 0000 0000								E7h
D8h	CCON 00X0 0000	CMOD 00XX X000	CCAPM0 X000 0000	CCAPM1 X000 0000	CCAPM2 X000 0000	CCAPM3 X000 0000	CCAPM4 X000 0000		DFh
D0h	PSW <sup>(1)</sup> 0000 0000	PSW1 <sup>(1)</sup> 0000 0000							D7h
C8h	T2CON 0000 0000	T2MOD XXXX XX00	RCAP2L 0000 0000	RCAP2H 0000 0000	TL2 0000 0000	TH2 0000 0000			CFh
C0h									C7h
B8h	IPL0 X000 0000	SADEN 0000 0000					SPH <sup>(1)</sup> 0000 0000		BFh
B0h	P3 1111 1111	IE1 XX0X XXX0	IPL1 XX0X XXX0	IPH1 XX0X XXX0				IPH0 X000 0000	B7h
A8h	IE0 0000 0000	SADDR 0000 0000							AFh
A0h	P2 1111 1111						WDTRST 1111 1111		A7h
98h	SCON 0000 0000	SBUF XXXX XXXX	BRL 0000 0000	BDRCON XXX0 0000	P1LS 0000 0000	P1IE 0000 0000	P1F 0000 0000		9Fh
90h	P1 1111 1111		SSBR 0000 0000	SSCON 0000 0000	SSCS (2)	SSDAT 0000 0000			97h
88h	TCON 0000 0000	TMOD 0000 0000	TL0 0000 0000	TL1 0000 0000	TH0 0000 0000	TH1 0000 0000	CKRL 0000 1000	POWM 0XXX 0XXX	8Fh
80h	P0 1111 1111	SP 0000 0111	DPL <sup>(1)</sup> 0000 0000	DPH <sup>(1)</sup> 0000 0000	DPXL <sup>(1)</sup> 0000 0001		PFILT XXXX XXXX	PCON 0000 0000	87h
	0/8	1/9	2/A	3/B	4/C	5/D	6/E	7/F	•

#### Table 12. SFR Addresses and Reset Values

reserved

Notes:

1. These registers are described in the TSC80251 Programmer's Guide (C251 core registers).

2. In read and write modes, SSCS is splitted in two separate registers. SSCS reset value is 1111 1000 in read mode and 0000 0000 in write mode.

### **6.4.** Configuration Bytes

The TSC87251G1A derivatives provide user design flexibility by configuring certain operating features at device reset. These features fall into the following categories:

- external memory interface (page mode, address bits, programmed wait states and the address range for RD#, WR#, and PSEN#)
- source mode/binary mode opcodes
- selection of bytes stored on the stack by an interrupt
- mapping of the upper portion of on-chip code memory to region 00:

Two user configuration bytes CONFIG0 (see Figure 6) and CONFIG1 (see Figure 7) provide the information.

For TSC87251G1A devices, configuration information is stored in on-chip separate memory (see paragraph 8. "EPROM Programming"). Whatever the EA# level, the configuration information is retrieved from this on-chip memory.

#### **CONFIG0**

Configuration Byte 0

7	6	5	4	3	2	1	0
_	-	WSA	XALE#	RD1	RD0	PAGE#	SRC

Bit Number	Bit Mnemonic	Description
7	-	Reserved Set this bit when writing to CONFIG0.
6	-	Reserved Set this bit when writing to CONFIG0.
5	WSA	Wait State A bits Clear to generate one wait state for all memory region except 01:. Set for no wait states for all memory region except 01:.
4	XALE#	<b>Extend ALE bit</b> Clear to extend the duration of the ALE pulse from $T_{OSC}$ to $3 \times T_{OSC}$ . Set to minimize the duration of the ALE pulse to $1 \times T_{OSC}$ .
3	RD1	Memory Signal Select bits Specify a 18 bit 17 bit or 16 bit avtornal address bus and the usage of PD# WP# and PSEN# signals
2	RD0	(see Table 13).
1	PAGE#	Page Mode Select bit Clear to select the faster page mode with A15:8/D7:0 on Port 2 and A7:0 on Port 0. Set to select the non-page mode <sup>(1)</sup> with A15:8 on Port 2 and A7:0/D7:0 on Port 0.
0	SRC	Source Mode/Binary Mode Select bit Clear to select the binary mode. Set to select the source mode.

#### Note:

1. This selection provides compatibility with the standard 80C51 hardware which is multiplexing the address LSB and the data on Port 0.

#### Figure 6. Configuration Byte 0

#### CONFIG1

Configuration Byte 1

7	6	5	4	3	2	1	0
-	-	-	INTR	WSB	-	-	EMAP#

Bit Number	Bit Mnemonic	Description
7	-	Reserved Set this bit when writing to CONFIG1.
6	_	Reserved Set this bit when writing to CONFIG1.
5	-	Reserved Set this bit when writing to CONFIG1.
4	INTR	Interrupt Mode bit <sup>(1)</sup> Clear so that the interrupts push two bytes onto the stack (the two lower bytes of the PC register). Set so that the interrupts push four bytes onto the stack (the three bytes of the PC register and the PSW1 register).
3	WSB	Wait State B bit Clear to generate one wait state for memory region 01:. Set for no wait states for memory region 01:.
2	-	Reserved Set this bit when writing to CONFIG1.
1	_	Reserved Set this bit when writing to CONFIG1.
0	EMAP#	On-Chip Code Memory Map bit Clear to map the upper 8 Kbytes of on-chip code memory (at FF:2000h-FF:3FFFh) to the data space (at 00:E000h-00:FFFFh). Set not to map the upper 8 Kbytes of on-chip code memory (at FF:2000h-FF:3FFFh) to the data space.

Note:

1. Two or four bytes are transparently popped according to INTR when using the RETI instruction. INTR must be set if interrupts are used with code executing outside region FF:.

#### **Figure 7. Configuration Byte 1**

Table	13. /	Address	Ranges	and	Usage	of RD#.	WR#	and	PSEN#	Signal	s
Table	10.1	luuress	Manges	anu	Usuge	or run,	** 1	anu		orgina	10

RD1	RD0	P1.7	P3.7/RD#	PSEN#	WR#	External Memory
0	0	A17	A16	Read signal for all external memory locations	Write signal for all external memory locations	256 Kbytes
0	1	I/O pin	A16	Read signal for all external memory locations	Write signal for all external memory locations	128 Kbytes
1	0	I/O pin	I/O pin	Read signal for all external memory locations	Write signal for all external memory locations	64 Kbytes
1	1	I/O pin	Read signal for regions 00: and 01:	Read signal for regions FE: and FF:	Write signal for all external memory locations	$2 \times 64 \text{ Kbytes}^{(1)}$

Note:

1. This selection provides compatibility with the standard 80C51 hardware which has separate external memory spaces for data and code.

# 7. Instruction Set Summary

This section contains tables that summarize the instruction set. For each instruction there is a short description, its length in bytes, and its execution time in states (one state time is equal to two system clock cycles). There are two concurrent processes limiting the effective instruction throughput:

- Instruction Fetch
- Instruction Execution

Table 20 to Table 34 assume code executing from on-chip memory, then the CPU is fetching 16-bit at a time and this is never limiting the execution speed.

If the code is fetched from external memory, a pre–fetch queue will store instructions ahead of execution to optimize the memory bandwidth usage when slower instructions are executed. However, the effective speed may be limited depending on the average size of instructions (for the considered section of the program flow). The maximum average instruction throughput is provided by Table 14 depending on the external memory configuration (from Page Mode to Non–Page Mode and the maximum number of wait states). If the average size of instructions is not an integer, the maximum effective throughput is found by pondering the number of states for the neighbor integer values.

Average size of	Page Mode	Non-Page Mode (states)					
Instructions (bytes)	(states)	0 Wait State	1 Wait State	2 Wait States			
1	1	2	3	4			
2	2	4	6	8			
3	3	6	9	12			
4	4	8	12	16			
5	5	10	15	20			

#### Table 14. Minimum Number of States per Instruction for given Average Sizes

If the average execution time of the considered instructions is larger than the number of states given by Table 14, this larger value will prevail as the limiting factor. Otherwise, the value from Table 14 must be taken. This is providing a fair estimation of the execution speed but only the actual code execution can provide the final value.

### 7.1. Notation for Instruction Operands

Table 15 to Table 19 provide Notation for Instruction Operands.

#### Table 15. Notation for Direct Addressing

Direct Address	Description	C251	C51
dir8	A direct 8-bit address. This can be a memory address (00h-7Fh) or a SFR address (80h-FFh). It is a byte (default), word or double word depending on the other operand.	~	~
dir16	A 16-bit memory address (00:0000h-00:FFFFh) used in direct addressing.	$\checkmark$	

#### Table 16. Notation for Immediate Addressing

Immediate Address	Description	C251	C51
#data	An 8-bit constant that is immediately addressed in an instruction	٢	1
#data16	A 16-bit constant that is immediately addressed in an instruction	7	
#0data16 #1data16	A 32-bit constant that is immediately addressed in an instruction. The upper word is filled with zeros (#0data16) or ones (#1data16).	/	
#short	A constant, equal to 1, 2, or 4, that is immediately addressed in an instruction.	7	

#### Table 17. Notation for Bit Addressing

Direct Address	Description	C251	C51
bit51	A directly addressed bit (bit number= 00h-FFh) in memory or an SFR. Bits 00h-7Fh are the 128 bits in byte locations 20h-2Fh in the on-chip RAM. Bits 80h-FFh are the 128 bits in the 16 SFRs with addresses that end in 0h or 8h, S:80h, S:88h, S:90h,, S:F0h, S:F8h.		/
bit	A directly addressed bit in memory locations 00:0020h-00:007Fh or in any defined SFR.	$\checkmark$	

#### Table 18. Notation for Destination in Control Instructions

Direct Address	Description	C251	C51
rel	A signed (two's complement) 8-bit relative address. The destination is $-128$ to $+127$ bytes relative to the next instruction's first byte.	7	7
addr11	An 11-bit target address. The target is in the same 2-Kbyte block of memory as the next instruction's first byte.		7
addr16	A 16-bit target address. The target can be anywhere within the same 64-Kbyte region as the next instruction's first byte.		7
addr24	A 24-bit target address. The target can be anywhere within the 16–Mbyte address space.	~	

### Table 19. Notation for Register Operands

Register	Description	C251	C51
@Ri	A memory location (00h-FFh) addressed indirectly via byte registers R0 or R1		7
Rn n	Byte register R0-R7 of the currently selected register bank Byte register index: n= 0-7		~
Rm Rmd Rms m, md, ms	Byte register R0-R15 of the currently selected register file Destination register Source register Byte register index: m, md, ms= 0-15	1	
WRj WRjd WRjs @WRj @WRj +dis16 j, jd, js	Word register WR0, WR2,, WR30 of the currently selected register file Destination register Source register A memory location (00:0000h-00:FFFFh) addressed indirectly through word register WR0-WR30, is the target address for jump instructions. A memory location (00:0000h-00:FFFFh) addressed indirectly through word register (WR0-WR30) + 16-bit signed (two's complement) displacement value Word register index: j, jd, js= 0-30	J	
DRk DRkd DRks @DRk @DRk +dis16 k, kd, ks	Dword register DR0, DR4,, DR28, DR56, DR60 of the currently selected register file Destination register Source register A memory location (00:0000h-FF:FFFFh) addressed indirectly through dword register DR0-DR28, DR56 and DR60, is the target address for jump instruction A memory location (00:0000h-FF:FFFFh) addressed indirectly through dword register (DR0-DR28, DR56, DR60) + 16-bit (two's complement) signed displacement value Dword register index: k, kd, ks= 0, 4, 8, 28, 56, 60	V	

#### 7.2. Size and Execution Time for Instruction Families

Add Subtract Add with Carry Subtract with Borrow		ADD <dest>, <src>dSUB <dest>, <src>dADDC <dest>, <src>(SUBB <dest>, <src>(</src></dest></src></dest></src></dest></src></dest>	dest opnd $\leftarrow$ dest opnd + src opnd dest opnd $\leftarrow$ dest opnd - src opnd (A) $\leftarrow$ (A) + src opnd + (CY) (A) $\leftarrow$ (A) - src opnd - (CY)				
Mnomonio	<dost> <sma>(1)</sma></dost>	Commonte		Binary	Mode	Source Mode	
whemome		Comments		Bytes	States	Bytes	States
	A, Rn	Register to ACC		1	1	2	2
	A, dir8	Direct address to ACC		2	1(2)	2	1(2)
ADD	A, @Ri	Indirect address to ACC		1	2	2	3
	A, #data	Immediate data to ACC		2	1	2	1
	Rmd, Rms	Byte register to/from byte register		3	2	2	1
	WRjd, WRjs	Word register to/from word register		3	3	2	2
	DRkd, DRks	Dword register to/from dword register		3	5	2	4
	Rm, #data	Immediate 8-bit data to/from byte register		4	3	3	2
	WRj, #data16	Immediate 16-bit data to/from word register		5	4	4	3
	DRk, #0data16	16-bit unsigned immediate data to/from dword re	gister	5	6	4	5
ADD / SUB	Rm, dir8	Direct address (on-chip RAM or SFR) to/from by register	yte	4	3(2)	3	2 <sup>(2)</sup>
	WRj, dir8	Direct address (on-chip RAM or SFR) to/from w register	ord	4	4	3	3
	Rm, dir16	Direct address (64K) to/from byte register		5	3(3)	4	2(3)
	WRj, dir16	Direct address (64K) to/from word register		5	4(4)	4	3(4)
	Rm, @WRj	Indirect address (64K) to/from byte register		4	3(3)	3	2(3)
	Rm, @DRk	Indirect address (16M) to/from byte register		4	4(3)	3	3(3)
	A, Rn	Register to/from ACC with carry		1	1	2	2
ADDC /	A, dir8	Direct address (on-chip RAM or SFR) to/from A with carry	.CC	2	1(2)	2	1(2)
SORR	A, @Ri	Indirect address to/from ACC with carry		1	2	2	3
	A, #data	Immediate data to/from ACC with carry		2	1	2	1

#### Table 20. Summary of Add and Subtract Instructions

Notes:

1. A shaded cell denotes an instruction in the C51 Architecture.

2. If this instruction addresses an I/O Port (Px, x= 0-3), add 1 to the number of states. Add 2 if it addresses a Peripheral SFR.

3. If this instruction addresses external memory location, add N+2 to the number of states (N: number of wait states).

4. If this instruction addresses external memory location, add 2(N+2) to the number of states (N: number of wait states).

Increment Increment Decrement Decrement		INC <dest> INC <dest>, <src> DEC <dest> DEC <dest>, <src></src></dest></dest></src></dest></dest>	dest opnd dest opnd dest opnd dest opnd	$nd \leftarrow dest opnd + 1$ $nd \leftarrow dest opnd + src opnd$ $nd \leftarrow dest opnd - 1$ $nd \leftarrow dest opnd - src opnd$			
Mnemonic	cdoats camps(1)	Comments	Binary Mode		Source Mode		
	<uest>, <src>(-)</src></uest>		Bytes	States	Bytes	States	
INC	А	ACC by 1		1	1	1	1
	Rn	Register by 1		1	1	2	2
DEC	dir8	Direct address (on-chip RAM or SFR) by 1		2	2 <sup>(2)</sup>	2	2 <sup>(2)</sup>
	@Ri	Indirect address by 1		1	3	2	4
INC	Rm, #short	Byte register by 1, 2, or 4		3	2	2	1
DEC	WRj, #short	Word register by 1, 2, or 4		3	2	2	1
INC	DRk, #short	Double word register by 1, 2, or 4		3	4	2	3
DEC	DRk, #short	Double word register by 1, 2, or 4		3	5	2	4
INC	DPTR	Data pointer by 1		1	1	1	1

#### Table 21. Summary of Increment and Decrement Instructions

Notes:

1. A shaded cell denotes an instruction in the C51 Architecture.

2. If this instruction addresses an I/O Port (Px, x= 0-3), add 2 to the number of states. Add 3 if it addresses a Peripheral SFR.

 Table 22. Summary of Compare Instructions

Compare		CMP <dest>, <src> dest opnd</src></dest>	- src opnd			
Marana	edants ennos (1)	Commente	Binary	v Mode	Source Mode	
winemonic	<uest>, <src>(-)</src></uest>	Comments	Bytes	States	Bytes	States
	Rmd, Rms	Register with register	3	2	2	1
	WRjd, WRjs	Word register with word register	3	3	2	2
	DRkd, DRks	Dword register with dword register	3	5	2	4
	Rm, #data	Register with immediate data	4	3	3	2
	WRj, #data16	Word register with immediate 16-bit data	5	4	4	3
	DRk, #0data16	Dword register with zero-extended 16-bit immediate data	5	6	4	5
CMP	DRk, #1data16	Dword register with one-extended 16-bit immediate data	5	6	4	5
	Rm, dir8	Direct address (on-chip RAM or SFR) with byte register	4	3(1)	3	2 <sup>(1)</sup>
	WRj, dir8	Direct address (on-chip RAM or SFR) with word register	4	4	3	3
	Rm, dir16	Direct address (64K) with byte register	5	3(2)	4	2 <sup>(2)</sup>
	WRj, dir16	Direct address (64K) with word register	5	4 <sup>(3)</sup>	4	3(3)
	Rm, @WRj	Indirect address (64K) with byte register	4	3(2)	3	2(2)
	Rm, @DRk	Indirect address (16M) with byte register	4	4(2)	3	3(2)

Notes:

1. If this instruction addresses an I/O Port (Px, x = 0-3), add 1 to the number of states. Add 2 if it addresses a Peripheral SFR.

2. If this instruction addresses external memory location, add N+2 to the number of states (N: number of wait states).

3. If this instruction addresses external memory location, add 2(N+2) to the number of states (N: number of wait states).

Logical AND <sup>(1)</sup>		ANL <dest>, <src> d</src></dest>	dest opnd $\leftarrow$ dest opnd A src opnd				
Logical OR <sup>(1)</sup>		ORL <dest>, <src> d</src></dest>	lest opnd	← dest opn	d V src opn	d	
Logical Exclusiv	ve OR <sup>(1)</sup>	XRL <dest>, <src> d</src></dest>	lest opnd	← dest opn	d ∀ src opn	d	
Clear <sup>(1)</sup>		CLR A (A	$\mathbf{A}) \leftarrow 0$				
Complement <sup>(1)</sup>		CPL A (A	$\mathbf{A}) \leftarrow \emptyset \ ($	(A)			
Rotate Left		RL A (4	$A)_{n+1} \leftarrow A_0 \leftarrow (A)_{n+1}$	$(A)_n, n=0$	.6		
Rotate Left Carr	У	RLC A	$A)_{n+1} \leftarrow CY) \leftarrow (A)_{n+1}$	$(A)_n, n=0$	.6		
		(4	$(A)_0 \leftarrow (CY)$				
Rotate Right		RR A (4	$A)_{n-1} \leftarrow A_{n-1} \leftarrow A_{$	$(A)_n, n=7$	1		
Rotate Right Ca	rry	RRC A (4	$A)_{n-1} \leftarrow$	$(A)_n, n=7$	1		
		(( (4)	$\begin{array}{l} (CY) \leftarrow (A) \\ (CY) \leftarrow (C) \end{array}$	4) <sub>0</sub> CY)			
Manania	(2)	Commente		Binary	Mode	Source	Mode
winemonic	<uest>, <src>(-)</src></uest>	Comments		Bytes	States	Bytes	States
	A, Rn	register to ACC		1	1	2	2
	A, dir8	Direct address (on-chip RAM or SFR) to ACC		2	1(3)	2	1(3)
	A, @Ri	Indirect address to ACC		1	2	2	3
	A, #data	Immediate data to ACC		2	1	2	1
	dir8, A	ACC to direct address		2	2(4)	2	2(4)
	dir8, #data	Immediate 8-bit data to direct address		3	3(4)	3	3(4)
	Rmd, Rms	Byte register to byte register		3	2	2	1
ANL	WRjd, WRjs	Word register to word register		3	3	2	2
XRL	Rm, #data	Immediate 8-bit data to byte register		4	3	3	2
	WRj, #data16	Immediate 16-bit data to word register		5	4	4	3
	Rm, dir8	Direct address to byte register		4	3(3)	3	2 <sup>(3)</sup>
	WRj, dir8	Direct address to word register		4	4	3	3
	Rm, dir16	Direct address (64K) to byte register		5	3(5)	4	2(5)
	WRj, dir16	Direct address (64K) to word register		5	4(6)	4	3(6)
	Rm, @WRj	Indirect address (64K) to byte register		4	3(5)	3	2(5)
	Rm, @DRk	Indirect address (16M) to byte register		4	4(5)	3	3(5)
CLR	А	Clear ACC		1	1	1	1
CPL	А	Complement ACC		1	1	1	1
RL	А	Rotate ACC left		1	1	1	1
RLC	А	Rotate ACC left through CY		1	1	1	1
RR	А	Rotate ACC right		1	1	1	1
RRC	А	Rotate ACC right through CY		1	1	1	1

#### Table 23. Summary of Logical Instructions (1/2)

Notes:

1. Logical instructions that affect a bit are in Table 29.

2. A shaded cell denotes an instruction in the C51 Architecture.

3. If this instruction addresses an I/O Port (Px, x= 0–3), add 1 to the number of states. Add 2 if it addresses a Peripheral SFR.

4. If this instruction addresses an I/O Port (Px, x= 0–3), add 2 to the number of states. Add 3 if it addresses a Peripheral SFR.

5. If this instruction addresses external memory location, add N+2 to the number of states (N: number of wait states).

6. If this instruction addresses external memory location, add 2(N+2) to the number of states (N: number of wait states).

Shift Left Logica	al	SLL <dest></dest>	$\langle \text{dest} \rangle_0 \leftarrow 0$ $\langle \text{dest} \rangle_{n+1} \leftarrow \langle \text{dest} \rangle_n, n=0msb-1$ $(CY) \leftarrow \langle \text{dest} \rangle_{n-1}$				
Shift Right Arithmetic		SRA <dest></dest>	$\langle \text{dest} \rangle_{\text{msb}} \leftarrow \langle \text{dest} \rangle_{\text{msb}}$ $\langle \text{dest} \rangle_{n-1} \leftarrow \langle \text{dest} \rangle_n, n= \text{msb1}$ $(CY) \leftarrow \langle \text{dest} \rangle_n$				
Shift Right Logi	cal	SRL <dest></dest>	$\langle \text{dest} \rangle_{\text{msb}} \leftarrow 0$ $\langle \text{dest} \rangle_{n-1} \leftarrow \langle \text{dest} \rangle_n, n= \text{msb1}$ $(\text{CY}) \leftarrow \langle \text{dest} \rangle_0$				
Swap		SWAP A	$A_{3:0} \Leftrightarrow A$	A7:4			
Mnomonio		Commente		Binary	v Mode	Source Mode	
Millemonic	<uest>, <src></src></uest>	Comments		Bytes	States	Bytes	States
CLI	Rm	Shift byte register left through the MSB		3	2	2	1
SLL	WRj	Shift word register left through the MSB		3	2	2	1
CD A	Rm	Shift byte register right		3	2	2	1
SKA	WRj	Shift word register right		3	2	2	1
CDI	Rm	Shift byte register left		3	2	2	1
SKL	WRj	Shift word register left		3	2	2	1
SWAP	А	Swap nibbles within ACC		1	2	1	2

#### Table 24. Summary of Logical Instructions (2/2)

Note:

1. A shaded cell denotes an instruction in the C51 Architecture.

#### Table 25. Summary of Multiply, Divide and Decimal-adjust Instructions

Mnemonic	<dest>, <src><sup>(1)</sup></src></dest>		Comments			-	~~~~		
				Binary	Mode	Source	e Mode		
THEN $(A)_{7:4} \leftarrow (A)_{7:4} + 6$									
Ior Addition (BC	.D)	IF[		If $(A)_{3:0} \leftarrow (A)_{3:0} + 0$ safects C 1, IF $[[(A)_{7:4} > 9] \lor [(CY)=1]]$					
Decimal-adjust A	ACC	DA A	IF [[(A)3:	IF $[[(A)_{3:0} > 9] \lor [(AC)=1]]$					
Divide		DIV <dest>, <src></src></dest>	ext. dest of ext. dest of	opnd high $\leftarrow$ Quotient (dest opnd/src opnd) opnd low $\leftarrow$ Remainder (dest opnd/src opnd					
<b></b>		<b>51</b>	$(B) \leftarrow Re$	mainder ((A)	nainder $((A)/(B))$				
Divide		DIV AB	$(A) \leftarrow Qu$	$(A) \leftarrow \text{Quotient} ((A)/(B))$					
wantpiy		MUL <dest>, <src></src></dest>	extended	xtended dest opnd $\leftarrow$ dest opnd $\times$ src opnd					
Multiply		MULAR	$(B:A) \leftarrow$	$-(A)\times(B)$					

Mnomonio	doct (1)	Commonte				
Winemonic		Comments	Bytes	States	Bytes	States
	AB	Multiply A and B	1	5	1	5
MUL	Rmd, Rms	Multiply byte register and byte register	3	6	2	5
	WRjd, WRjs	Multiply word register and word register	3	12	2	11
	AB	Divide A and B	1	10	1	10
DIV	Rmd, Rms	Divide byte register and byte register	3	11	2	10
	WRjd, WRjs	Divide word register and word register	3	21	2	20
DA	А	Decimal adjust ACC	1	1	1	1

Note:

1. A shaded cell denotes an instruction in the C51 Architecture.

Move to High v	vord	MOVH <dest>, <src> dest</src></dest>	dest opnd <sub>31:16</sub> $\leftarrow$ src opnd				
Move with Sign	n extension	MOVS <dest>, <src> dest&gt;</src></dest>	dest opnd $\leftarrow$ src opnd with sign extend				
Move with Zero	o extension	MOVZ <dest>, <src> dest&gt;</src></dest>	est opnd $\leftarrow$	src opnd v	with zero ex	tend	
Move Code		MOVC A, <src> (A</src>	A) $\leftarrow$ src op	ond			
Move eXtended	1	MOVX <dest>, <src> dest</src></dest>	est opnd $\leftarrow$	src opnd			
Mnomonio	Inomonia dosta cons <sup>(1)</sup>		Binary	Mode	Source Mode		
winemonic	<uest>, <src>(-)</src></uest>	Comments		Bytes	States	Bytes	States
MOVH	DRk, #data16	16-bit immediate data into upper word of dword	d register	5	3	4	2
MOVS	WRj, Rm	Byte register to word register with sign extension	on	3	2	2	1
MOVZ	WRj, Rm	Byte register to word register with zeros extens	ion	3	2	2	1
MOVG	A, @A+DPTR	Code byte relative to DPTR to ACC		1	6 <sup>(3)</sup>	1	6 <sup>(3)</sup>
MOVC	A, @A +PC	Code byte relative to PC to ACC		1	6(3)	1	6(3)
	A, @Ri	Extended memory (8-bit address) to ACC <sup>(2)</sup>		1	4	1	5
MONA	A, @DPTR	Extended memory (16-bit address) to ACC <sup>(2)</sup>		1	3(4)	1	3(4)
MOVX	@Ri, A	ACC to extended memory (8-bit address) <sup>(2)</sup>		1	4	1	4
	@DPTR, A	ACC to extended memory (16-bit address) <sup>(2)</sup>		1	4(3)	1	4(3)

#### Table 26. Summary of Move Instructions (1/3)

Notes:

1. A shaded cell denotes an instruction in the C51 Architecture.

2. Extended memory addressed is in the region specified by DPXL (reset value= 01h).

3. If this instruction addresses external memory location, add N+1 to the number of states (N: number of wait states).

4. If this instruction addresses external memory location, add N+2 to the number of states (N: number of wait states).

#### Table 27. Summary of Move Instructions (2/3)

Move <sup>(1)</sup>	]	MOV <dest>, <src> dest opnd ←</src></dest>	- src opnd			
Mnomonio	edants cano (2)	Comments	Binary Mode		Source Mode	
Millemonic		Comments	Bytes	States	Bytes	States
	A, Rn	Register to ACC	1	1	2	2
	A, dir8	Direct address (on-chip RAM or SFR) to ACC	2	1(3)	2	1(3)
	A, @Ri	Indirect address to ACC	1	2	2	3
	A, #data	Immediate data to ACC	2	1	2	1
	Rn, A	ACC to register	1	1	2	2
	Rn, dir8	Direct address (on-chip RAM or SFR) to register	2	1(3)	3	2(3)
MOV	Rn, #data	Immediate data to register	2	1	3	2
	dir8, A	ACC to direct address	2	2(3)	2	2(3)
	dir8, Rn	Register to direct address	2	2 <sup>(3)</sup>	3	3(3)
	dir8, dir8	Direct address to direct address	3	3(4)	3	3(4)
	dir8, @Ri	Indirect address to direct address	2	3(3)	3	4(3)
	dir8, #data	Immediate data to direct address	3	3(3)	3	3(3)
	@Ri, A	ACC to indirect address	1	3	2	4
	@Ri, dir8	Direct address to indirect address	2	3(3)	3	4(3)
	@Ri, #data	Immediate data to indirect address	2	3	3	4
	DPTR, #data16	Load Data Pointer with a 16-bit constant	3	2	3	2

Notes:

1. Instructions that move bits are in Table 29.

2. Move instructions from the C51 Architecture.

3. If this instruction addresses an I/O Port (Px, x= 0-3), add 1 to the number of states. Add 2 if it addresses a Peripheral SFR.

4. Apply note 3 for each dir8 operand.

Move <sup>(1)</sup>	MOV <dest>, <src> dest opnd ← src opnd</src></dest>					
			Binary	v Mode	Source	e Mode
Mnemonic	$\langle dest \rangle, \langle src \rangle^{(2)}$	Comments	Bytes	States	Bytes	States
	Rmd, Rms	Byte register to byte register	3	2	2	1
	WRjd, WRjs	Word register to word register	3	2	2	1
	DRkd, DRks	Dword register to dword register	3	3	2	2
	Rm, #data	Immediate 8-bit data to byte register	4	3	3	2
	WRj, #data16	Immediate 16-bit data to word register	5	3	4	2
	DRk, #0data16	zero-ext 16bit immediate data to dword register	5	5	4	4
	DRk, #1data16	one-ext 16bit immediate data to dword register	5	5	4	4
	Rm, dir8	Direct address to byte register	4	3(3)	3	2 <sup>(3)</sup>
	WRj, dir8	Direct address to word register	4	4	3	3
	DRk, dir8	Direct address to dword register	4	6	3	5
	Rm, dir16	Direct address (64K) to byte register	5	3(4)	4	2(4)
	WRj, dir16	Direct address (64K) to word register	5	4 <sup>(5)</sup>	4	3(5)
	DRk, dir16	Direct address (64K) to dword register	5	6(6)	4	5(6)
	Rm, @WRj	Indirect address (64K) to byte register	4	3(4)	3	2(4)
	Rm, @DRk	Indirect address (16M) to byte register	4	4(4)	3	3(4)
	WRjd, @WRjs	Indirect address (64K) to word register	4	4(5)	3	3(5)
	WRj, @DRk	Indirect address (16M) to word register	4	5(5)	3	4 <sup>(5)</sup>
	dir8, Rm	Byte register to direct address	4	4(3)	3	3(3)
MOV	dir8, WRj	Word register to direct address	4	5	3	4
	dir8, DRk	Dword register to direct address	4	7	3	6
	dir16, Rm	Byte register to direct address (64K)	5	4(4)	4	3(4)
	dir16, WRj	Word register to direct address (64K)	5	5(5)	4	4(5)
	dir16, DRk	Dword register to direct address (64K)	5	7(6)	4	6(6)
	@WRj, Rm	Byte register to indirect address (64K)	4	4(4)	3	3(4)
	@DRk, Rm	Byte register to indirect address (16M)	4	5(4)	3	4(4)
	@WRjd, WRjs	Word register to indirect address (64K)	4	5 <sup>(5)</sup>	3	4 <sup>(5)</sup>
	@DRk, WRj	Word register to indirect address (16M)	4	6 <sup>(5)</sup>	3	5(5)
	Rm, @WRj +dis16	Indirect with 16-bit dis (64K) to byte register	5	6(4)	4	5(4)
	WRj, @WRj +dis16	Indirect with 16-bit dis (64K) to word register	5	7(5)	4	6 <sup>(5)</sup>
	Rm, @DRk +dis24	Indirect with 16-bit dis (16M) to byte register	5	7(4)	4	6(4)
	WRj, @WRj +dis24	Indirect with 16-bit dis (16M) to word register	5	8(5)	4	7 <sup>(5)</sup>
	@WRj +dis16, Rm	Byte register to indirect with 16-bit dis (64K)	5	6(4)	4	5(4)
	@WRj +dis16, WRj	Word register to indirect with 16-bit dis (64K)	5	7(5)	4	6 <sup>(5)</sup>
	@DRk +dis24, Rm	Byte register to indirect with 16-bit dis (16M)	5	7(4)	4	6(4)
	@DRk +dis24, WRj	Word register to indirect with 16-bit dis (16M)	5	8(5)	4	7(5)

#### Table 28. Summary of Move Instructions (3/3)

Notes:

1. Instructions that move bits are in Table 29.

2. Move instructions unique to the C251 Architecture.

3. If this instruction addresses an I/O Port (Px, x = 0-3), add 1 to the number of states. Add 2 if it addresses a Peripheral SFR.

5. If this instruction addresses external memory location, add 2(N+1) to the number of states (N: number of wait states).

6. If this instruction addresses external memory location, add 4(N+2) to the number of states (N: number of wait states).



Clear Bit Set Bit Complement Bit AND Carry with Bit AND Carry with Complement of Bit OR Carry with Complement of Bit OR Carry with Complement of Bit Move Bit to Carry Move Bit from Carry		CLR <dest>dest opndSETB <dest>dest opndCPL <dest>dest opndANL CY, <src>(CY) <math>\leftarrow</math> (CANL CY, <src>(CY) <math>\leftarrow</math> (CORL CY, <src>(CY) <math>\leftarrow</math> (CORL CY, <src>(CY) <math>\leftarrow</math> (CMOV CY, <src>(CY) <math>\leftarrow</math> srMOV <dest>, CYdest opnd</dest></src></src></src></src></src></dest></dest></dest>		$\begin{array}{l} \mathbf{i} \leftarrow 0 \\ \mathbf{d} \leftarrow 1 \\ \mathbf{d} \leftarrow \varnothing \text{ bit} \\ (\mathrm{CY}) \land \mathrm{src opnd} \\ (\mathrm{CY}) \land \varnothing \mathrm{src opnd} \\ (\mathrm{CY}) \lor \varnothing \mathrm{src opnd} \\ (\mathrm{CY}) \lor \varnothing \mathrm{src opnd} \\ \mathrm{src opnd} \\ \mathbf{d} \leftarrow (\mathrm{CY}) \end{array}$				
Mnemonic	<dest>, <src><sup>(1)</sup></src></dest>	Comments		Binary	Mode	Source	Mode	
				Bytes	States	Bytes	States	
	CY	Clear carry		1	1	1	1	
CLR	bit51	Clear direct bit		2	2 <sup>(3)</sup>	2	2 <sup>(3)</sup>	
	bit	Clear direct bit		4	4(3)	3	3(3)	
	СҮ	Set carry	et carry			1	1	
SETB	bit51	Set direct bit	2	2(3)	2	2 <sup>(3)</sup>		
	bit	Set direct bit		4	4(3)	3	3(3)	
	CY Complement carry			1	1	1	1	
CPL	bit51	Complement direct bit	2	2(3)	2	2 <sup>(3)</sup>		
	bit	Complement direct bit	4	4(3)	3	3(3)		
	CY, bit51	And direct bit to carry		2	1(2)	2	1(2)	
A NT	CY, bit	And direct bit to carry		4	3(2)	3	2 <sup>(2)</sup>	
ANL	CY, /bit51	And complemented direct bit to carry		2	1(2)	2	1(2)	
	CY, /bit	And complemented direct bit to carry		4	3(2)	3	2 <sup>(2)</sup>	
	CY, bit51	Or direct bit to carry		2	1(2)	2	1(2)	
OPI	CY, bit	Or direct bit to carry		4	3(2)	3	2 <sup>(2)</sup>	
UKL	CY, /bit51	Or complemented direct bit to carry		2	1(2)	2	1 <sup>(2)</sup>	
	CY, /bit	Or complemented direct bit to carry	4	3(2)	3	2 <sup>(2)</sup>		
	CY, bit51	Move direct bit to carry		2	1(2)	2	1(2)	
MOV	CY, bit	Move direct bit to carry		4	3(2)	3	2 <sup>(2)</sup>	
1410 4	bit51, CY	Move carry to direct bit		2	2 <sup>(3)</sup>	2	2 <sup>(3)</sup>	
	bit, CY	Move carry to direct bit		4	4(3)	3	3(3)	

#### **Table 29. Summary of Bit Instructions**

Notes:

1. A shaded cell denotes an instruction in the C51 Architecture.

- 2. If this instruction addresses an I/O Port (Px, x= 0-3), add 1 to the number of states. Add 2 if it addresses a Peripheral SFR.
- 3. If this instruction addresses an I/O Port (Px, x=0-3), add 2 to the number of states. Add 3 if it addresses a Peripheral SFR.

# TEMIC Semiconductors

Exchange bytes Exchange Digit Push		XCH A, <src>(AXCHD A, <src>(APUSH <src>(S</src></src></src>	(A) $\leftrightarrow$ src opnd (A) <sub>3:0</sub> $\leftrightarrow$ src opnd <sub>3:0</sub> (SP) $\leftarrow$ (SP) +1; ((SP)) $\leftarrow$ src opnd;				
Рор		POP <dest> (S) de</dest>	$(SP) \leftarrow (SP) + size (src opnd) - 1$ $(SP) \leftarrow (SP) - size (dest opnd) + 1;$ $dest opnd \leftarrow ((SP)); (SP) \leftarrow (SP) - 1$				
Manager		C		Binary	Mode	Source Mode	
Minemonic	<dest>, <src>(1)</src></dest>	Comments		Bytes	States	Bytes	States
	A, Rn	ACC and register		1	3	2	4
XCH	A, dir8	ACC and direct address (on-chip RAM or SFR)		2	3(3)	2	3(3)
	A, @Ri	ACC and indirect address	CC and indirect address				5
XCHD	A, @Ri	ACC low nibble and indirect address (256 bytes)		1	4	2	5
	dir8	Push direct address onto stack		2	2 <sup>(2)</sup>	2	2 <sup>(2)</sup>
	#data	Push immediate data onto stack	4	4	3	3	
DUCU	#data16	Push 16-bit immediate data onto stack		5	5	4	5
rusn	Rm	Push byte register onto stack		3	4	2	3
	WRj	Push word register onto stack		3	5	2	4
	DRk	Push double word register onto stack		3	9	2	8
	dir8	Pop direct address (on-chip RAM or SFR) from sta	ack	2	3(2)	2	3(2)
DOD	Rm	Pop byte register from stack		3	3	2	2
rur	WRj	Pop word register from stack		3	5	2	4
	DRk	Pop double word register from stack	Pop double word register from stack			2	8

#### Table 30. Summary of Exchange, Push and Pop Instructions

#### Notes:

1. A shaded cell denotes an instruction in the C51 Architecture.

2. If this instruction addresses an I/O Port (Px, x= 0-3), add 1 to the number of states. Add 2 if it addresses a Peripheral SFR.

3. If this instruction addresses an I/O Port (Px, x= 0-3), add 2 to the number of states. Add 3 if it addresses a Peripheral SFR.

#### Table 31. Summary of Conditional Jump Instructions (1/2)

Jump conditional on status Jcc rel (PC) IF [cc			PC) + size (i HEN (PC) ←	instr); - (PC) + rel		
Maamaatia	cidents comes (1)	B		Mode <sup>(2)</sup>	Source Mode <sup>(2)</sup>	
Minemonic	<uest>, <src>(2)</src></uest>	Comments	Bytes	States	Bytes	States
JC	rel	Jump if carry	2	1/4(3)	2	1/4(3)
JNC	rel	Jump if not carry	2	1/4(3)	2	1/4(3)
JE	rel	Jump if equal	3	2/5(3)	2	1/4(3)
JNE	rel	Jump if not equal	3	2/5(3)	2	1/4(3)
JG	rel	Jump if greater than	3	2/5 <sup>(3)</sup>	2	1/4 <sup>(3)</sup>
JLE	rel	Jump if less than, or equal	3	2/5(3)	2	1/4(3)
JSL	rel	Jump if less than (signed)	3	2/5 <sup>(3)</sup>	2	1/4(3)
JSLE	rel	Jump if less than, or equal (signed)	3	2/5 <sup>(3)</sup>	2	1/4(3)
JSG	rel	Jump if greater than (signed)	3	2/5 <sup>(3)</sup>	2	1/4(3)
JSGE	rel	Jump if greater than or equal (signed)	3	2/5 <sup>(3)</sup>	2	1/4 <sup>(3)</sup>

#### Notes:

1. A shaded cell denotes an instruction in the C51 Architecture.

2. States are given as jump not-taken/taken.

3. In internal execution only, add 1 to the number of states of the 'jump taken' if the destination address is internal and odd.

Jump if bit	JB <src>, rel</src>	$(PC) \leftarrow (PC) + size (instr);$ IF [src opnd= 1] THEN $(PC) \leftarrow (PC) + rel$
Jump if not bit	JNB <src>, rel</src>	$(PC) \leftarrow (PC) + size (instr);$ IF [src opnd= 0] THEN $(PC) \leftarrow (PC) + rel$
Jump if bit and clear	JBC <dest>, rel</dest>	$(PC) \leftarrow (PC) + size (instr);$ IF [dest opnd=1] THEN dest opnd $\leftarrow 0$ $(PC) \leftarrow (PC) + rel$
Jump if accumulator is zero	JZ rel	$(PC) \leftarrow (PC) + size (instr);$ IF [(A)= 0] THEN (PC) $\leftarrow$ (PC) + rel
Jump if accumulator is not zero	JNZ rel	$(PC) \leftarrow (PC) + size (instr);$ IF $[(A) \neq 0]$ THEN $(PC) \leftarrow (PC) + rel$
Compare and jump if not equal	CJNE <src1>, <src2>, rel</src2></src1>	$(PC) \leftarrow (PC) + size (instr);$ IF [src opnd1 < src opnd2] THEN (CY) $\leftarrow 1$ IF [src opnd1 ≥ src opnd2] THEN (CY) $\leftarrow 0$ IF [src opnd1 ≠ src opnd2] THEN (PC) $\leftarrow (PC) + rel$
Decrement and jump if not zero	DJNZ <dest>, rel</dest>	$(PC) \leftarrow (PC) + size (instr); dest opnd \leftarrow dest opnd -1;$ IF $[\emptyset(Z)]$ THEN $(PC) \leftarrow (PC) + rel$

#### Table 32. Summary of Conditional Jump Instructions (2/2)

Maaaaa	(1)	Commonto		Mode <sup>(2)</sup>	Source Mode <sup>(2)</sup>	
Minemonic	<uest>, <src>(-)</src></uest>	Comments	Bytes	States	Bytes	States
ID	bit51, rel	Jump if direct bit is set	3	2/5(3)(6)	3	2/5(3)(6)
1R	bit, rel	Jump if direct bit of 8-bit address location is set	5	4/7(3)(6)	4	3/6 <sup>(3)(6)</sup>
DID	bit51, rel	Jump if direct bit is not set	3	2/5(3)(6)	3	2/5(3)(6)
JNB	bit, rel	Jump if direct bit of 8-bit address location is not set	5	4/7(3)(6)	4	3/6 <sup>(3)</sup>
bit51, rel		Jump if direct bit is set & clear bit	3	4/7 <sup>(5)(6)</sup>	3	4/7 <sup>(5)(6)</sup>
JBC	bit, rel	Jump if direct bit of 8-bit address location is set and clear	5	7/10 <sup>(5)(6)</sup>	4	6/9 <sup>(5)(6)</sup>
JZ	rel	Jump if ACC is zero	2	2/5(6)	2	2/5(6)
JNZ	rel	Jump if ACC is not zero	2	2/5 <sup>(6)</sup>	2	2/5 <sup>(6)</sup>
	A, dir8, rel	Compare direct address to ACC and jump if not equal	3	2/5(3)(6)	3	2/5(3)(6)
CDUE	A, #data, rel	Compare immediate to ACC and jump if not equal	3	2/5 <sup>(6)</sup>	3	2/5(6)
CJNE	Rn, #data, rel	Compare immediate to register and jump if not equal	3	2/5 <sup>(6)</sup>	4	3/6 <sup>(6)</sup>
	@Ri, #data, rel	Compare immediate to indirect and jump if not equal	3	3/6 <sup>(6)</sup>	4	4/7(6)
DNZ	Rn, rel	Decrement register and jump if not zero	2	2/5(6)	3	3/6 <sup>(6)</sup>
DJNZ	dir8, rel	Decrement direct address and jump if not zero	3	3/6 <sup>(4)(6)</sup>	3	3/6 <sup>(4)(6)</sup>

Notes:

1. A shaded cell denotes an instruction in the C51 Architecture.

2. States are given as jump not-taken/taken.

3. If this instruction addresses an I/O Port (Px, x = 0-3), add 1 to the number of states. Add 2 if it addresses a Peripheral SFR.

4. If this instruction addresses an I/O Port (Px, x= 0-3), add 2 to the number of states. Add 3 if it addresses a Peripheral SFR.

5. If this instruction addresses an I/O Port (Px, x= 0-3), add 3 to the number of states. Add 5 if it addresses a Peripheral SFR.

6. In internal execution only, add 1 to the number of states of the 'jump taken' if the destination address is internal and odd.

Absolute jump Extended jump Long jump Short jump Jump indirect No operation		AJMP <src>(PCEJMP <src>(PCLJMP <src>(PCSJMP rel(PCJMP @A +DPTR(PCNOP(PC</src></src></src>	$(PC) \leftarrow (PC) +2; (PC)_{10:0} \leftarrow \text{src opnd}$ $(PC) \leftarrow (PC) + \text{size (instr)}; (PC)_{23:0} \leftarrow \text{src opnd}$ $(PC) \leftarrow (PC) + \text{size (instr)}; (PC)_{15:0} \leftarrow \text{src opnd}$ $(PC) \leftarrow (PC) +2; (PC) \leftarrow (PC) + \text{rel}$ $(PC)_{23:16} \leftarrow FFh; (PC)_{15:0} \leftarrow (A) + (DPTR)$ $(PC) \leftarrow (PC) +1$				ond ond
Maamania	edaata canaa (1)			<b>Binary Mode</b>		Source Mode	
Minemonic <uest>, <src>&lt;-/ul&gt;</src></uest>		Comments		Bytes	States	Bytes	States
AJMP	addr11	Absolute jump		2	3(2)(3)	2	3(2)(3)
EDAD	addr24	Extended jump	xtended jump		6 <sup>(2)(4)</sup>	4	5(2)(4)
@DRk		Extended jump (indirect)		3	7(2)(4)	2	6 <sup>(2)(4)</sup>
	@WRj	Long jump (indirect)		3	6 <sup>(2)(4)</sup>	2	5(2)(4)
LJMP	addr16	Long jump (direct address)		3	5(2)(4)	3	5(2)(4)
SJMP	rel	Short jump (relative address)		2	4(2)(4)	2	4(2)(4)
JMP	@A+DPTR	Jump indirect relative to the DPTR		1	5(2)(4)	1	5(2)(4)
NOP		No operation (Jump never)		1	1	1	1

#### Table 33. Summary of unconditional Jump Instructions

Notes:

1. A shaded cell denotes an instruction in the C51 Architecture.

2. In internal execution only, add 1 to the number of states if the destination address is internal and odd.

3. Add 2 to the number of states if the destination address is external.

4. Add 3 to the number of states if the destination address is external.

#### Table 34. Summary of Call and Return Instructions

Absolute call	ACALL <src></src>	$(PC) \leftarrow (PC) + 2$ ; push $(PC)_{15:0}$ ;
		$(PC)_{10:0} \leftarrow src opnd$
Extended call	ECALL <src></src>	$(PC) \leftarrow (PC) + size (instr); push (PC)_{23:0};$
		$(PC)_{23:0} \leftarrow src opnd$
Long call	LCALL <src></src>	$(PC) \leftarrow (PC) + size (instr); push (PC)_{15:0};$
		$(PC)_{15:0} \leftarrow src opnd$
Return from subroutine	RET	pop (PC) <sub>15:0</sub>
Extended return from subroutine	ERET	pop (PC) <sub>23:0</sub>
Return from interrupt	RETI	IF [INTR= 0] THEN pop $(PC)_{15:0}$
-		IF [INTR=1] THEN pop (PC) <sub>23:0</sub> ; pop (PSW1)
Trap interrupt	TRAP	$(PC) \leftarrow (PC) + size (instr);$
		IF [INTR= 0] THEN push $(PC)_{15:0}$
		IF [INTR= 1] THEN push (PSW1); push (PC) <sub>23:0</sub>

Mnomonio	edants ennos(1)	Comments		Mode	Source Mode	
winemonic	Tome vests, sites v Comments		Bytes	States	Bytes	States
ACALL	addr11	Absolute subroutine call	2	9(2)(3)	2	9(2)(3)
ECALL	@DRk	Extended subroutine call (indirect)	3	14(2)(3)	2	13(2)(3)
ECALL	addr24	Extended subroutine call	5	14(2)(3)	4	13(2)(3)
LCALL	@WRj	Long subroutine call (indirect)	3	10 <sup>(2)(3)</sup>	2	9(2)(3)
LCALL	addr16	Long subroutine call	3	9(2)(3)	3	9(2)(3)
RET		Return from subroutine	1	7 <sup>(2)</sup>	1	7 <sup>(2)</sup>
ERET		Extended subroutine return 3		9(2)	2	8(2)
RETI		Return from interrupt	1	7(2)(4)	1	7(2)(4)
TRAP		Jump to the trap interrupt vector	2	12(4)	1	11(4)

Notes:

1. A shaded cell denotes an instruction in the C51 Architecture.

2. In internal execution only, add 1 to the number of states if the destination/return address is internal and odd.

3. Add 2 to the number of states if the destination address is external.

4. Add 5 to the number of states if INTR = 1.

TEMIC Semiconductors

# 8. EPROM Programming

### 8.1. Internal ROM Features

The internal ROM of the TSC87251G1A products contains five different areas:

- Code Memory
- Configuration Bytes
- Lock Bits
- Encryption Array
- Signature Bytes

### 8.1.1. EPROM/OTPROM Devices

All the Internal ROM but the Signature Bytes of the TSC87251G1A products is made of EPROM cells. The Signature Bytes of the TSC87251GxD products are made of Mask ROM.

The TSC87251G1A products are programmed and verified in the same manner as TEMIC's TSC87251G1 and TSC87251A1A, using a SINGLE–PULSE algorithm, which programs at VPP= 12.75V using only one 100  $\mu$ s pulse per byte. This results in a programming time of less than 5 seconds for the 16 Kbytes on–chip code memory.

The EPROM of TSC87251G1A products in Window CQPJ is erasable by Ultra–Violet radiation (UV). UV erasure set all the EPROM memory cells to one and allows a reprogramming. The quartz window must be covered with an opaque label when the device is in operation. This is not so much to protect the EPROM array from inadvertent erasure, as to protect the RAM and other on–chip logic. Allowing light to impinge on the silicon die during device operation may cause a logical malfunction.

Note:

Erasure of the EPROM begins to occur when the chip is exposed to light wavelength shorter than 4000Å. Since sunlight and fluorescent light have wavelength in this range, exposure to these light sources over an extended time (1 week in sunlight or 3 years in room–level fluorescent lighting) could cause inadvertent erasure.

The TSC87251G1A products in plastic packages are One Time Programmable (OTP). Then an EPROM cell cannot be reset by UV once programmed to zero.

#### **8.1.2. Security Features**

In some microcontrollers applications, it is desirable that the user program code be secured from unauthorized access. The TSC87251G1A offers two kinds of protection for program code stored in the on–chip array:

- Program code in the on-chip Code Memory is encrypted when read out for verification if the Encryption Array is programmed.
- A three–level lock bit system restricts external access to the on–chip code memory.

#### 8.1.3. Lock Bit System

The TSC87251G1A products implement 3 levels of security for User's program as described in Table 35.

The first level locks the programming of the User's internal Code Memory, the Configuration Bytes and the Encryption Array.

The second level locks the verifying of the User's internal Code Memory. It is always possible to verify the Configuration Bytes and the Lock Bits. It is never possible to verify the Encryption Array.

The third level locks the external execution.

Level	Lock bits LB[2:0]	Internal Execution	External Execution	Verification	Programming	External PROM read (MOVC)
0	000	Enable	Enable	Enable <sup>(1)</sup>	Enable	Enable <sup>(2)</sup>
1	001	Enable	Enable	Enable <sup>1)</sup>	Disable	Disable
2	011	Enable	Enable	Disable	Disable	Disable
3	111	Enable	Disable	Disable	Disable	Disable
Reserved	Other	х	Х	Х	X	x

#### Table 35. Lock bits Programming

Notes:

1. Returns encrypted data if Encryption Array is programmed.

2. Returns non encrypted data.

Level 1 should be set before programming Level 2; Level 2 should be set before programming Level 3.

The security level may be verified according to Table 36.

#### Table 36. Lock bits Verifying

Level	Lock bits Data <sup>(1)</sup>
0	xxxxx000
1	xxxxx001
2	xxxxx01x
3	xxxxx1xx

Note:

1. x means don't care.

#### 8.1.4. Encryption Array

The TSC87251G1A products include a 128–byte Encryption Array located in non–volatile memory outside the memory address space. During verification of the on–chip code memory, the seven low–order address bits also address the Encryption Array. As the byte of the code memory is read, it is exclusive–NOR'ed (XNOR) with the key byte from the Encryption Array. If the Encryption Array is not programmed (still all 1s), the user program code is placed on the data bus in its original, unencrypted form. If the Encryption Array is programmed with key bytes, the user program code is encrypted and cannot be used without knowledge of the key byte sequence.

To preserve the secrecy of the encryption key byte sequence, the Encryption Array can not be verified.

Cautions:

1. When a MOVC instruction is executed, the content of the ROM is not encrypted. In order to fully protect the user program code, the lock bit level 1 (see Table 1) must always be set when encryption is used.

2. If the encryption feature is implemented, the portion of the on-chip code memory that does not contain program code should be filled with "random" byte values to prevent the encryption key sequence from being revealed.

### 8.2. Signature Bytes

The TSC87251G1A products contain factory–programmed Signature Bytes. These bytes are located in non–volatile memory outside the memory address space at 30h, 31h, 60h and 61h. To read the Signature Bytes, perform the procedure described in section 8.4., "Verify Algorithm", using the verify signature mode (see Table 39). Signature byte values are listed in Table 37.

		Signature Address	Signature Data
Vendor	TEMIC	30h	58h
Architecture	C251	31h	40h
Memory	16K EPROM/OTPROM	60h	FBh
Revision	First (TSC8x251G1A)	61h	FFh

#### Table 37. Signature Bytes (Electronic ID)

### 8.3. Programming Algorithm

Figure 8 shows the hardware setup needed to program the TSC87251G1A EPROM areas:

- The chip has to be put under reset and maintained in this state until the completion of the programming sequence.
- PSEN# and the other control signals (ALE and Port 0) have to be set to a high level.
- Then PSEN# has to be to forced to a low level after two clock cycles or more and it has to be maintained in this state until the completion of the programming sequence (see below).
- The voltage on the EA# pin must be set to VDD.
- The programming mode is selected according to the code applied on Port 0 (see Table 38). It has to be applied until the completion of this programming operation.
- The programming address is applied on Ports 1 and 3 which are respectively the Most Significant Byte (MSB) and the Least Significant Byte (LSB) of the address.
- The programming data are applied on Port 2.
- The EPROM Programming is done by raising the voltage on the EA# pin to VPP, then by generating a low level pulse on ALE/PROG# pin.
- The voltage on the EA# pin must be lowered to VDD before completing the programming operation.
- It is possible to alternate programming and verifying operation (See paragraph 8.4.). Please make sure the voltage on the EA# pin has actually been lowered to VDD before performing the verifying operation.
- PSEN# and the other control signals have to be released to complete a sequence of programming operations or a sequence of programming and verifying operations.



Figure 8. Setup for EPROM Programming

#### Table 38. Programming Modes

ROM Area <sup>(1)</sup>	RST	EA#/VPP	PSEN#	ALE/PROG# <sup>(2)</sup>	PO	P2	P1(MSB) P3(LSB)
On-chip Code Memory	1	VPP	0	1 Pulse	68h	Data	16–bit Address 0000h-3FFFh (16K)
Configuration Bytes	1	VPP	0	1 Pulse	69h	Data	CONFIG0: 0080h CONFIG1: 0081h
Lock Bits	1	VPP	0	1 Pulse	6Bh	Х	LB0: 0001h LB1: 0002h LB2: 0003h
Encryption Array	1	VPP	0	1 Pulse	6Ch	Data	0000h-007Fh

#### Notes:

1. Signature Bytes are not user-programmable.

2. The ALE/PROG# pulse waveform is shown in Figure 24 page 46.

### 8.4. Verify Algorithm

Figure 9 shows the hardware setup needed to verify the TSC87251G1A EPROM areas:

- The chip has to be put under reset and maintained in this state until the completion of the verifying sequence.
- PSEN# and the other control signals (ALE and Port 0) have to be set to a high level.
- Then PSEN# has to be to forced to a low level after two clock cycles or more and it has to be maintained in this state until the completion of the verifying sequence (see below).
- The voltage on the EA# pin must be set to VDD and ALE must be set to a high level.
- The Verifying Mode is selected according to the code applied on Port 0. It has to be applied until the completion of this verifying operation.
- The verifying address is applied on Ports 1 and 3 which are respectively the MSB and the LSB of the address.
- Then device is driving the data on Port 2.
- It is possible to alternate programming and verification operation (see paragraph 8.3.). Please make sure the voltage on the EA# pin has actually been lowered to VDD before performing the verifying operation.
- PSEN# and the other control signals have to be released to complete a sequence of verifying operations or a sequence of programming and verifying operations.

ROM Area <sup>(1)</sup>	RST	EA#/VPP	PSEN#	ALE/PROG#	PO	P2	P1(MSB) P3(LSB)
On-chip code memory	1	1	0	1	28h	Data	16–bit Address 0000h-3FFFh (16K)
Configuration Bytes	1	1	0	1	29h	Data	CONFIG0: 0080h CONFIG1: 0081h
Lock Bits	1	1	0	1	2Bh	Data	0000h
Signature Bytes	1	1	0	1	29h	Data	0030h, 0031h, 0060h, 0061h

#### Table 39. Verifying Modes

#### Note:

1. To preserve the secrecy of on-chip code memory when encypted, the Encryption Array can not be verified.





Figure 9. Setup for EPROM Verifying

# 9. Absolute Maximum Rating and Operating Conditions

### 9.1. Absolute Maximum Rating

**Table 40. Absolute Maximum Ratings** 

•	Storage Temperature	-65 to +150°C
•	Voltage on any other Pin to VSS	–0.5 to +6.5 V
•	Voltage on EA#/VPP Pin to VSS	0 to +13.0 V
•	I <sub>OL</sub> per I/O Pin	15 mA
•	Power Dissipation	1.5 W

### 9.2. Operating Conditions

#### **Table 41. Operating Conditions**

•	Ambient Temperature Under Bias	
	Commercial	0 to +70°C
	Industrial	$-40 \text{ to } +85^{\circ}\text{C}$
•	V <sub>DD</sub>	4.5 to 5.5 V

#### Note:

Stressing the device beyond the "Absolute Maximum Ratings" may cause permanent damage. These are stress ratings only. Operation beyond the "operating conditions" is not recommended and extended exposure beyond the "Operating Conditions" may affect device reliability.

# **10. DC Characteristics – Commercial & Industrial**

Symbol	Parameter	Min	Typical <sup>(4)</sup>	Max	Units	Test Conditions	
V <sub>IL</sub>	Input Low Voltage (except EA#, SCL, SDA)	-0.5		0.2V <sub>DD</sub> - 0.1	V		
V <sub>IL1</sub> <sup>(5)</sup>	Input Low Voltage (SCL, SDA)	-0.5		0.3V <sub>DD</sub>	V		
V <sub>IL2</sub>	Input Low Voltage (EA#)	0		0.2V <sub>DD</sub> - 0.3	V		
V <sub>IH</sub>	Input high Voltage (except XTAL1, RST, SCL, SDA)	$0.2V_{DD} + 0.9$		V <sub>DD</sub> + 0.5	V		
V <sub>IH1</sub> <sup>(5)</sup>	Input high Voltage (XTAL1, RST, SCL, SDA)	0.7V <sub>DD</sub>		V <sub>DD</sub> + 0.5	V		
V <sub>OL</sub>	Output Low Voltage (Ports 1, 2, 3)			0.3 0.45 1.0	V		
V <sub>OL1</sub>	Output Low Voltage (Ports 0, ALE, PSEN#,Port 2 in Page Mode during External Address)			0.3 0.45 1.0	V	$ I_{OL} = 200 \ \mu A^{(1)(2)} \\ I_{OL} = 3.2 \ m A^{(1)(2)} \\ I_{OL} = 7.0 \ m A^{(1)(2)} $	
V <sub>OH</sub>	Output high Voltage (Ports 1, 2, 3, ALE, PSEN#)	V <sub>DD</sub> -0.3 V <sub>DD</sub> -0.7 V <sub>DD</sub> -1.5			V		
V <sub>OH1</sub>	Output high Voltage (Port 0, Port 2 in Page Mode during External Address)	V <sub>DD</sub> -0.3 V <sub>DD</sub> -0.7 V <sub>DD</sub> -1.5			V	$I_{OH}$ = -200 µA $I_{OH}$ = -3.2 mA $I_{OH}$ = -7.0 mA	
V <sub>RST</sub> +	Reset threshold on		3.7		V		
V <sub>RST</sub> -	Reset threshold off		3.3		V		
V <sub>RET</sub>	V <sub>DD</sub> data retention limit			1.8	V	V	
I <sub>IL0</sub>	Logical 0 Input Current (Ports 1, 2, 3)			- 50	μΑ	V <sub>IN</sub> = 0.45 V	
I <sub>LI</sub>	Input Leakage Current (Port 0)			± 10	μΑ	$0.45 \text{ V} < V_{IN} < V_{DD}$	
I <sub>TL</sub>	Logical 1-to-0 Transition Current (Ports 1, 2, 3)			- 650	μΑ	V <sub>IN</sub> = 2.0 V	
R <sub>RST</sub>	RST Pull-Down Resistor	40	170	225	kΩ		
C <sub>IO</sub>	Pin Capacitance		10		pF	$T_A = 25^{\circ}C$	
T	Or anting Comment		35	65	mA	F <sub>OSC</sub> = 12 MHz	
IDD	Operating Current		45	80	mA	F <sub>OSC</sub> = 16 MHz	
T			10	15	mA	F <sub>OSC</sub> = 12 MHz	
I <sub>DL</sub>	Idle Mode Current		15	20	mA	F <sub>OSC</sub> = 16 MHz	
I <sub>PD</sub>	Power-Down Current		10	20	μΑ	$V_{RET} < V_{DD} < 5.5 V$	
V <sub>PP</sub>	Programming Supply Voltage	12,5		13	V	$T_A = 0$ to $+40^{\circ}C$	
I <sub>PP</sub>	Programming Supply Current			75	mA	$T_A = 0$ to $+40^{\circ}C$	

### Table 42. DC Characteristics; $V_{DD}{=}$ 4.5 to 5.5 V, $T_{A}{=}$ –40 to +85 $^{\circ}{\rm C}$

Notes:

1. Under steady-state (non-transient) conditions, I<sub>OL</sub> must be externally limited as follows:

Maximum I <sub>OL</sub> per port pin:	10 mA
Maximum IOL per 8-bit port:	Port 0 26 mA
	Ports 1-3 15 mA
Maximum Total I <sub>OL</sub> for all:	Output Pins 71 mA
If lot exceeds the test conditions.	Vor may exceed the related spec

If  $I_{OL}$  exceeds the test conditions,  $V_{OL}$  may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.

- 2. Capacitive loading on Ports 0 and 2 may cause spurious noise pulses above 0.4 V on the low-level outputs of ALE and Ports 1, 2, and 3. The noise is due to external bus capacitance discharging into the Port 0 and Port 2 pins when these pins change from high to low. In applications where capacitive loading exceeds 100 pF, the noise pulses on these signals may exceed 0.8 V. It may be desirable to qualify ALE or other signals with a Schmitt Trigger or CMOS-level input logic.
- 3. Capacitive loading on Ports 0 and 2 causes the  $V_{OH}$  on ALE and PSEN# to drop below the specification when the address lines are stabilizing. 4. Typical values are obtained using  $V_{DD} = 5$  V and  $T_A = 25^{\circ}$ C with no guarantee.
- *They are not tested and there is not guarantee on these values.*
- 5. The input threshold voltage of SCL and SDA meets the l<sup>2</sup>C specification, so an input voltage below 0.3.V<sub>DD</sub> will be recognized as a logic 0 while an input voltage above 0.7.V<sub>DD</sub> will be recognized as a logic 1.



Note:

1. The clock prescaler is not used:  $F_{OSC} = F_{XTAL}$ .

Figure 10.  $I_{DD}/I_{DL}$  versus Frequency;  $V_{DD}$ = 4.5 to 5.5 V

### 10.1. DC Characteristics: $I_{DD,}\,I_{DL}$ and $I_{PD}$ Test Conditions



Figure 11. I<sub>DD</sub> Test Condition, Active Mode



Figure 12. I<sub>DL</sub> Test Condition, Idle Mode



Figure 13. IPD Test Condition, Power–Down Mode

# 11. AC Characteristics – Commercial & Industrial

### 11.1. AC Characteristics – External Bus Cycles

### **Definition of symbols**

Fable 43. External	<b>Bus Cycles</b>	<b>Timing Symbol</b>	Definitions
--------------------	-------------------	----------------------	-------------

Signals		
А	Address	
D	Data In	
L	ALE	
Q	Data Out	
R	RD#/PSEN#	
W	WR#	

Conditions		
Н	High	
L	Low	
V	Valid	
Х	No Longer Valid	
Z	Floating	

#### Timings

Test conditions: capacitive load on all pins= 50 pF.

Table 44 lists AC timing parameters for the TSC87251G1A with no wait states. External wait states can be added by extending PSEN#/RD#/WR# and or by extending ALE. In these tables, Note 2 marks parameters affected by one ALE wait state, and Note 3 marks parameters affected by one PSEN#/RD#/WR# wait state.

Figure 14 to Figure 19 show the bus cycles with the timing parameters.



Growbal	Donomotor	16 N	MHz	F <sub>OSC</sub> V	F <sub>OSC</sub> Variable	
Symbol	rarameter	Min	Max	Min	Max	Unit
T <sub>OSC</sub>	1/F <sub>OSC</sub>	63				ns
T <sub>LHLL</sub>	ALE Pulse Width	53		T <sub>OSC</sub> -10		ns <sup>(2)</sup>
T <sub>AVLL</sub>	Address Valid to ALE Low	43		T <sub>OSC</sub> -20		ns <sup>(2)</sup>
T <sub>LLAX</sub>	Address hold after ALE Low	43		T <sub>OSC</sub> -20		ns
T <sub>RLRH</sub> <sup>(1)</sup>	RD#/PSEN# Pulse Width	45		T <sub>OSC</sub> -18		ns <sup>(3)</sup>
T <sub>RHRL</sub>	RD#/PSEN# High to RD#/PSEN# Low	53		T <sub>OSC</sub> -10		ns
T <sub>WLWH</sub>	WR# Pulse Width	45		T <sub>OSC</sub> -18		ns <sup>(3)</sup>
T <sub>LLRL</sub> <sup>(1)</sup>	ALE Low to RD#/PSEN# Low	53		T <sub>OSC</sub> -10		ns
T <sub>LHAX</sub>	ALE High to Address Hold	105		2×T <sub>OSC</sub> -20		ns <sup>(2)</sup>
T <sub>RLDV</sub> <sup>(1)</sup>	RD#/PSEN# Low to Valid Data		43		T <sub>OSC</sub> -20	ns <sup>(3)</sup>
T <sub>RHDX</sub> <sup>(1)</sup>	Data Hold After RD#/PSEN# High	0		0		ns
T <sub>RHAX</sub> <sup>(1)</sup>	Address Hold After RD#/PSEN# High	0		0		ns
T <sub>RLAZ</sub> <sup>(1)</sup>	RD#/PSEN# Low to Address Float		2		2	ns
T <sub>RHDZ1</sub>	Instruction Float After RD#/PSEN# High		43		T <sub>OSC</sub> -20	ns
T <sub>RHDZ2</sub>	Data Float After RD#/PSEN# High		43		T <sub>OSC</sub> -20	ns
T <sub>RHLH1</sub>	RD#/PSEN# high to ALE High (Instruction)	48		T <sub>OSC</sub> -15		ns
T <sub>RHLH2</sub>	RD#/PSEN# high to ALE High (Data)	173		3×T <sub>OSC</sub> -15		ns
T <sub>WHLH</sub>	WR# High to ALE High	173		3×T <sub>OSC</sub> -15		ns
T <sub>AVDV1</sub>	Address (P0) Valid to Valid Data In		190		3×T <sub>OSC</sub> -60	ns <sup>(2)(3)</sup>
T <sub>AVDV2</sub>	Address (P2) Valid to Valid Data In		273		4×T <sub>OSC</sub> -60	ns <sup>(2)(3)</sup>
T <sub>AVDV3</sub>	Address (P0) Valid to Valid Instruction In		128		3×T <sub>OSC</sub> -60	ns
T <sub>AXDX</sub>	Data Hold after Address Hold	0		0		ns
T <sub>AVRL</sub> <sup>(1)</sup>	Address Valid to RD# Low	101		2×T <sub>OSC</sub> -24		ns (2)
T <sub>AVWL1</sub>	Address (P0) Valid to WR# Low	101		2×T <sub>OSC</sub> -24		ns (2)
T <sub>AVWL2</sub>	Address (P2) Valid to WR# Low	158		3×T <sub>OSC</sub> -30		ns (2)
T <sub>WHQX</sub>	Data Hold after WR# High	43		T <sub>OSC</sub> -20		ns
T <sub>QVWH</sub>	Data Valid to WR# High	38		T <sub>OSC</sub> -25		ns <sup>(3)</sup>
T <sub>WHAX</sub>	WR# High to Address Hold	105		2×T <sub>OSC</sub> -20		ns

### Table 44. Bus Cycles AC Timings; $V_{DD}$ = 4.5 to 5.5 V, $T_A$ = -40 to 85°C

Notes:

1. Specification for PSEN# are identical to those for RD#.

2. If a wait state is added by extending ALE, add  $2 \times T_{OSC}$ .

3. If a wait state is added by extending RD#/PSEN#/WR#, add  $2\times T_{OSC}$ .

#### Waveforms in Non-Page Mode



#### Note:

1. The value of this parameter depends on wait states. See Table 44.

Figure 14. External Bus Cycle: Code Fetch (Non-Page Mode)



#### Note:

1. The value of this parameter depends on wait states. See Table 44.

Figure 15. External Bus Cycle: Data Read (Non-Page Mode)

# TEMIC Semiconductors

# TSC87251G1A



#### Note:

1. The value of this parameter depends on wait states. See Table 44.

#### Figure 16. External Bus Cycle: DataWrite (Non-Page Mode)

#### Waveforms in Page Mode



#### Notes:

- 1. The value of this parameter depends on wait states. See Table 44.
- 2. A page hit (i.e., a code fetch to the same 256-byte "page" as the previous code fetch) requires one state (2×T<sub>OSC</sub>); a page miss requires two states (4×T<sub>OSC</sub>).
- 3. During a sequence of page hits, PSEN# toggles between each byte fetching.

#### Figure 17. External Bus Cycle: Code Fetch (Page Mode)



#### Note:

1. The value of this parameter depends on wait states. See Table 44.

Figure 18. External Bus Cycle: Data Read (Page Mode)



#### Note:

1. The value of this parameter depends on wait states. See Table 44.

Figure 19. External Bus Cycle: DataWrite (Page Mode)

TEMIC

Semiconductors

### 11.2. AC Characteristics – Serial Port in Shift Register Mode

#### **Definition of symbols**

Table 45.	Serial Port	Timing	Symbol	Definitions
Iupic 40.	Der lar I Of C	- <b>-</b>	Symbol	Definitions

Signals		
D	Data In	
Q	Data Out	
Х	Clock	

Conditions		
Н	High	
L	Low	
V	Valid	
Х	No Longer Valid	

#### Timings

### Table 46. Serial Port AC Timing –Shift Register Mode; $V_{DD}$ = 4.5 to 5.5 V, $T_A$ = –40 to 85°C

Symbol	Parameter	16 MHz		F <sub>OSC</sub> Variable		TT 14
		Min	Max	Min	Max	Omt
T <sub>XLXL</sub>	Serial Port Clock Cycle Time	756		12×T <sub>OSC</sub>		ns
T <sub>QVXH</sub>	Output Data Setup to Clock Rising Edge	620		12×T <sub>OSC</sub> -136		ns
T <sub>XHQX</sub>	Output Data hold after Clock Rising Edge	510		10×T <sub>OSC</sub> -120		ns
T <sub>XHDX</sub>	Input Data Hold after Clock Rising Edge	0		0		ns
T <sub>XHDV</sub>	Clock Rising Edge to Input Data Valid		500		10×T <sub>OSC</sub> -130	ns

### Waveforms



#### Note:

1. TI and RI are set during S1P1 of the peripheral cycle following the shift of the eight bit.

#### Figure 20. Serial Port Waveforms – Shift Register Mode

## 11.3. AC Characteristics – SSLC: I<sup>2</sup>C Interface

#### Timings

Symbol	Parameter	INPUT	OUTPUT	
		Min Max	Min Max	
Thd; STA	Start condition hold time	14×TCLCL <sup>(4)</sup>	4.0 μs <sup>(1)</sup>	
TLOW	SCL low time	16×TCLCL <sup>(4)</sup>	4.7 μs <sup>(1)</sup>	
Тнібн	SCL high time	14×TCLCL <sup>(4)</sup>	4.0 μs <sup>(1)</sup>	
TRC	SCL rise time	1 µs	_ (2)	
TFC	SCL fall time	0.3 µs	0.3 μs <sup>(3)</sup>	
Tsu; DAT1	Data set-up time	250 ns	20×TCLCL <sup>(4)</sup> – TRD	
Tsu; DAT2	SDA set-up time (before repeated START condition)	250 ns	1 µs <sup>(1)</sup>	
Tsu; DAT3	SDA set-up time (before STOP condition)	250 ns	8×TCLCL <sup>(4)</sup>	
Thd; DAT	Data hold time	0 ns	8×TCLCL <sup>(4)</sup> – TFC	
Tsu; STA	Repeated START set-up time	14×TCLCL <sup>(4)</sup>	4.7 μs <sup>(1)</sup>	
Tsu; STO	STOP condition set-up time	14×TCLCL <sup>(4)</sup>	4.0 μs <sup>(1)</sup>	
TBUF	Bus free time	14×TCLCL <sup>(4)</sup>	4.7 μs <sup>(1)</sup>	
Trd	SDA rise time	1 µs	_(2)	
Tfd	SDA fall time	0.3 µs	0.3 μs <sup>(3)</sup>	

#### Table 47. I<sup>2</sup>C Interface AC Timing; $V_{DD}$ = 4.5 to 5.5 V, $T_A$ = -40 to 85°C

Notes:

1. At 100 kbit/s. At other bit-rates this value is inversely proportional to the bit-rate of 100 kbit/s.

2. Determined by the external bus-line capacitance and the external bus-line pull-up resistor, this must be  $< 1 \, \mu s$ .

3. Spikes on the SDA and SCL lines with a duration of less than 3×TCLCL will be filtered out. Maximum capacitance on bus–lines SDA and SCL= 400 pF.

4.  $T_{CLCL} = T_{OSC} = one \ oscillator \ clock \ period.$ 

### Waveforms



Figure 21. I<sup>2</sup>C Waveforms

### 11.4. AC Characteristics – SSLC: SPI Interface

### **Definition of symbols**

	Signals
С	Clock
Ι	Data In
0	Data Out

#### Table 48. SPI Interface Timing Symbol Definitions

Conditions			
Н	High		
L	Low		
V	Valid		
Х	No Longer Valid		

#### Timings

### Table 49. SPI Interface AC Timing; $V_{DD}{=}$ 4.5 to 5.5 V, $T_{A}{=}$ –40 to 85°C

Symbol	Parameter	Min	Max	Unit			
Master mode <sup>(1)</sup>	Master mode <sup>(1)</sup>						
T <sub>CHCH</sub>	Clock Period	4		T <sub>OSC</sub>			
T <sub>CHCX</sub>	Clock High Time	1.6		T <sub>OSC</sub>			
T <sub>CLCX</sub>	Clock Low Time	1.6		T <sub>OSC</sub>			
T <sub>IVCL</sub> , T <sub>IVCH</sub>	Input Data Valid to Clock Edge	50		ns			
T <sub>CLIX</sub> , T <sub>CHIX</sub>	Input Data Hold after Clock Edge	50		ns			
T <sub>CLOV,</sub> T <sub>CHOV</sub>	Output Data Valid after Clock Edge		65	ns			
T <sub>CLOX</sub> , T <sub>CHOX</sub>	Output Data Hold Time after Clock Edge	0		ns			
T <sub>ILIH</sub>	Input Data Rise Time		2	μs			
T <sub>IHIL</sub>	Input Data Fall Time		2	μs			
T <sub>OLOH</sub>	Output Data Rise time		50	ns			
T <sub>OHOL</sub>	Output Data Fall Time		50	ns			

Notes:

1. Capacitive load on all pins= 100 pF in master mode.

#### Waveforms



Note:

1. SS# handled by software.

Figure 22. SPI Master Waveforms (SSCPHA= 0)



Note:

1. SS# handled by software.

Figure 23. SPI Master Waveforms (SSCPHA=1)

### **11.5.** AC Characteristics – EPROM Programming and Verifying

### **Definition of symbols**

Signals				
А	Address			
Е	Enable: mode set on Port 0			
Q Data Out				

Conditions			
Н	High		
L	Low		
V	Valid		
Х	No Longer Valid		
Z	Floating		

### Timings

### Table 51. EPROM Programming and Verifying AC timings; $V_{DD}$ = 4.5 to 5.5 V, $T_A$ = 0 to 40°C

Table 50. EPROM Programming & Verifying Timing Symbol Definitions

Symbol	Parameter	Min	Max	Unit
T <sub>OSC</sub>	XTAL1 Frequency	83.5	250	ns
T <sub>AVGL</sub>	Address Setup to PROG# low	48×T <sub>OSC</sub>		
T <sub>GHAX</sub>	Address Hold after PROG# low	48×T <sub>OSC</sub>		
T <sub>DVGL</sub>	Data Setup to PROG# low	48×T <sub>OSC</sub>		
T <sub>GHDX</sub>	Data Hold after PROG#	48×T <sub>OSC</sub>		
T <sub>EHSH</sub>	ENABLE High to VPP	48×T <sub>OSC</sub>		
T <sub>SHGL</sub>	VPP Setup to PROG# low	10		μs
T <sub>GHSL</sub>	VPP Hold after PROG#	10		μs
T <sub>SLEL</sub>	ENABLE Hold after VPP	0		
T <sub>GLGH</sub>	PROG# Width	90	110	μs
T <sub>AVQV</sub>	Address to Data Valid		48×T <sub>OSC</sub>	
T <sub>AXQX</sub>	Address to Data Invalid	0		ns
T <sub>ELQV</sub>	ENABLE low to Data Valid		48×T <sub>OSC</sub>	
T <sub>EHQZ</sub>	Data Float after ENABLE	0	48×T <sub>OSC</sub>	



#### Waveforms



Figure 24. EPROM Programming Waveforms



Figure 25. EPROM Verifying Waveforms

### 11.6. AC Characteristics – External Clock Drive and Logic Level References

#### **Definition of symbols**

Table 52. External Clock Timing Symbol Definitions

Signals			
С	Clock		

Conditions		
L	Low	
Н	High	
X No Longer Valid		

TEMIC Semiconductors

# TSC87251G1A

#### Timings

#### Table 53. External Clock AC Timings; $V_{DD}$ = 4.5 to 5.5 V, $T_A$ = -40 to +85°C

Symbol	Parameter	Min	Max	Unit
F <sub>OSC</sub>	Oscillator Frequency		24	MHz
T <sub>CHCX</sub>	High Time	10		ns
T <sub>CLCX</sub>	Low Time	10		ns
T <sub>CLCH</sub>	Rise Time	3		ns
T <sub>CHCL</sub>	Fall Time	3		ns

#### Waveforms



#### Figure 26. External Clock Waveform



#### Note:

During AC testing, all inputs are driven at  $V_{DD}$  –0.5 V for a logic 1 and 0.45 V for a logic 0. Timing measurements are made on all outputs at  $V_{IH}$  min for a logic 1 and  $V_{IL}$  max for a logic 0.

#### Figure 27. AC Testing Input/Output Waveforms



Note:

For timing purposes, a port pin is no longer floating when a 100 mV change from load voltage occurs and begins to float when a 100 mV change from the loading  $V_{OH}/V_{OL}$  level occurs with  $I_{OL}/I_{OH} = \pm 20$  mA.

#### Figure 28. Float Waveforms

# 12. Packages

### 12.1. List of Packages

- PDIL 40
- PLCC 44
- CQPJ 44

### 12.2. PDIL 40 – Mechanical Outline



Figure 29: Plastic Dual In Line

#### Table 54: PDIL Package Size

	MM		IN	СН
	Min	Max	Min	Max
А	_	5.08	_	.200
A1	0.38	_	.015	-
A2	3.18	4.95	.125	.195
В	0.36	0.56	.014	.022
B1	0.76	1.78	.030	.070
С	0.20	0.38	.008	.015
D	50.29	53.21	1.980	2.095
Е	15.24	15.87	.600	.625
E1	12.32	14.73	.485	.580
е	2.54 H	3.S.C.	.100 B.S.C.	
eA	15.24	B.S.C.	.600 B.S.C.	
eB	_	17.78	_	.700
L	2.93	3.81	.115	.150
D1	0.13	_	.005	_

### 12.3. PLCC 44 – Mechanical Outline



Figure 30: Plastic Lead Chip Carrier

Table	55:	PLC	C P	Package	Size
-------	-----	-----	-----	---------	------

	MM		INCH	
	Min	Max	Min	Max
А	4.20	4.57	.165	.180
A1	2.29	3.04	.090	.120
D	17.40	17.65	.685	.695
D1	16.44	16.66	.647	.656
D2	14.99	16.00	.590	.630
Е	17.40	17.65	.685	.695
E1	16.44	16.66	.647	.656
E2	14.99	16.00	.590	.630
e	1.27 BSC		.050 BSC	
G	1.07	1.22	.042	.048
Н	1.07	1.42	.042	.056
J	0.51	_	.020	_
K	0.33	0.53	.013	.021
Nd	11		11	
Ne	11		1	1

# 12.4. CQPJ 44 with Window – Mechanical Outline



Figure 31: Ceramic Quad Pack J

Table 56: COPJ Package size	Table 56:	COPJ	Package	size
-----------------------------	-----------	------	---------	------

	MM		INCH	
	Min	Max	Min	Max
А	_	4.90	_	.193
С	0.15	0.25	.006	.010
D - E	17.40	17.55	.685	.691
D1 – E1	16.36	16.66	.644	.656
e	1.27 TYP		.050 TYP	
f	0.43	0.53	.017	.021
J	0.86	1.12	.034	.044
Q	15.49	16.00	.610	.630
R	0.86 TYP		.034	ТҮР
N1	11		1	1
N2	11		1	1

# **13. Ordering Information**

### 13.1. TSC87251G1A OTP (Step A)

#### High Speed Versions 4.5 to 5.5 V, Commercial and Industrial

TEMIC Part Number	ROM	Description
TSC87251G1A-16CA	16K OTP ROM	16 MHz, Commercial 0° to 70°C, PDIL 40
TSC87251G1A-16CB	16K OTP ROM	16 MHz, Commercial 0° to 70°C, PLCC 44
TSC87251G1A-16IA	16K OTP ROM	16 MHz, Industrial -40° to 85°C, PDIL 40
TSC87251G1A-16IB	16K OTP ROM	16 MHz, Industrial -40° to 85°C, PLCC 44

### 13.2. TSC87251G1A EPROM – UV Window package (Step A)

#### High Speed Versions 4.5 to 5.5 V, Industrial

TEMIC Part Number	ROM	Description	
TSC87251G1A-16IC	16K EPROM	16 MHz, Industrial -40° to 85°C, window CQPJ 44	

### 13.3. TSC80251G1D ROMless (Step D)

#### High Speed Versions 4.5 to 5.5 V, Commercial and Industrial

TEMIC Part Number <sup>(2)</sup>	ROM	Description
TSC80251G1D-24CA	ROMless	24 MHz, Commercial 0° to 70°C, PDIL 40
TSC80251G1D-24CB	ROMless	24 MHz, Commercial 0° to 70°C, PLCC 44
TSC80251G1D-24CED	ROMless	24 MHz, Commercial 0° to 70°C, VQFP 44, Dry pack <sup>(1)</sup>
TSC80251G1D-16CA	ROMless	16 MHz, Commercial 0° to 70°C, PDIL 40
TSC80251G1D-16CB	ROMless	16 MHz, Commercial 0° to 70°C, PLCC 44
TSC80251G1D-16CED	ROMless	16 MHz, Commercial 0° to 70°C, VQFP 44, Dry pack <sup>(1)</sup>
TSC80251G1D-16IA	ROMless	16 MHz, Industrial -40° to 85°C, PDIL 40
TSC80251G1D-16IB	ROMless	16 MHz, Industrial -40° to 85°C, PLCC 44

### Low Voltage Versions 2.7 to 5.5 V, Commercial

TEMIC Part Number <sup>(2)</sup>	ROM	Description
TSC80251G1D-L12CB	ROMless	12 MHz, Commercial, PLCC 44
TSC80251G1D-L12CED	ROMless	12 MHz, Commercial, VQFP 44, Dry pack <sup>(1)</sup>

### 13.4. TSC83251G1D Mask ROM (Step D)

#### High Speed Versions 4.5 to 5.5 V, Commercial and Industrial

TEMIC Part Number <sup>(2)</sup>	ROM	Description
TSC251G1Dxxx-24CA	16K MaskROM	24 MHz, Commercial 0° to 70°C, PDIL 40
TSC251G1Dxxx-24CB	16K MaskROM	24 MHz, Commercial 0° to 70°C, PLCC 44
TSC251G1Dxxx-24CED	16K MaskROM	24 MHz, Commercial 0° to 70°C, VQFP 44, Dry pack <sup>(1)</sup>
TSC251G1Dxxx-16CA	16K MaskROM	16 MHz, Commercial 0° to 70°C, PDIL 40
TSC251G1Dxxx-16CB	16K MaskROM	16 MHz, Commercial 0° to 70°C, PLCC 44
TSC251G1Dxxx-16CED	16K MaskROM	16 MHz, Commercial 0° to 70°C, VQFP 44, Dry pack <sup>(1)</sup>
TSC251G1Dxxx-16IA	16K MaskROM	16 MHz, Industrial –40° to 85°C, PDIL 40
TSC251G1Dxxx-16IB	16K MaskROM	16 MHz, Industrial -40° to 85°C, PLCC 44

#### Low Voltage Versions 2.7 to 5.5 V, Commercial

TEMIC Part Number <sup>(2)</sup>	ROM	Description
TSC251G1Dxxx-L12CB	16K MaskROM	12 MHz, Commercial 0° to 70°C, PLCC 44
TSC251G1Dxxx-L12CED	16K MaskROM	12 MHz, Commercial 0° to 70°C, VQFP 44, Dry pack <sup>(1)</sup>

Notes:

1. Dry Pack mandatory for VQFP package.

2. xxx: means ROM code, is Cxxx in case of encrypted code.

#### 13.5. Options (Please consult TEMIC sales)

- ROM code encryption
- Tape & Real or Dry Pack
- Known good dice
- Ceramic packages
- Extended temperature range: -55°C to +125°C

### 13.6. Starter Kit

TEMIC Part Number	Description	
TSC80251–SK	TSC80251 Starter Kit	

### **13.7. Product Marking**

Mask ROM versions TEMIC Customer Part number Temic Part number ® INTEL'97 YYWW . Lot Number ROMless versions

TEMIC Temic Part number ® INTEL'97

YYWW . Lot Number

OTP versions

TEMIC Temic Part number ® INTEL'95 YYWW . Lot Number

> \_\_\_\_\_\_ Rev. A — September 21, 1998